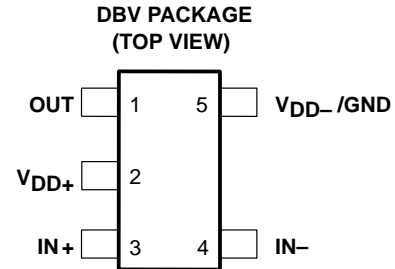


**TLV2731, TLV2731Y**  
**Advanced LinCMOS™ RAIL-TO-RAIL**  
**LOW-POWER SINGLE OPERATIONAL AMPLIFIERS**

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- **Output Swing Includes Both Supply Rails**
- **Low Noise . . . 15 nV/√Hz Typ at f = 1 kHz**
- **Low Input Bias Current . . . 1 pA Typ**
- **Fully Specified for Single-Supply 3-V and 5-V Operation**
- **Common-Mode Input Voltage Range Includes Negative Rail**
- **High Gain Bandwidth . . . 2 MHz at V<sub>DD</sub> = 5 V with 600 Ω Load**
- **High Slew Rate . . . 1.6 V/μs at V<sub>DD</sub> = 5 V**
- **Wide Supply Voltage Range 2.7 V to 10 V**
- **Macromodel Included**



**description**

The TLV2731 is a single low-voltage operational amplifier available in the SOT-23 package. It offers 2 MHz of bandwidth and 1.6 V/μs of slew rate for applications requiring good ac performance. The device exhibits rail-to-rail output performance for increased dynamic range in single or split supply applications. The TLV2731 is fully characterized at 3 V and 5 V and is optimized for low-voltage applications.

The TLV2731, exhibiting high input impedance and low noise, is excellent for small-signal conditioning of high-impedance sources, such as piezoelectric transducers. Because of the micropower dissipation levels combined with 3-V operation, these devices work well in hand-held monitoring and remote-sensing applications. In addition, the rail-to-rail output feature with single- or split-supplies makes this family a great choice when interfacing with analog-to-digital converters (ADCs). The device can also drive 600-Ω loads for telecom applications.

With a total area of 5.6mm<sup>2</sup>, the SOT-23 package only requires one-third the board space of the standard 8-pin SOIC package. This ultra-small package allows designers to place single amplifiers very close to the signal source, minimizing noise pick-up from long PCB traces.

**AVAILABLE OPTIONS**

T <sub>A</sub>	V <sub>IO</sub> max AT 25°C	PACKAGED DEVICES	SYMBOL	CHIP FORM‡ (Y)
		SOT-23 (DBV)†		
0°C to 70°C	3 mV	TLV2731CDBV	VALC	TLV2731Y
-40°C to 85°C	3 mV	TLV2731IDBV	VALI	

† The DBV package available in tape and reel only.

‡ Chip forms are tested at T<sub>A</sub> = 25°C only.



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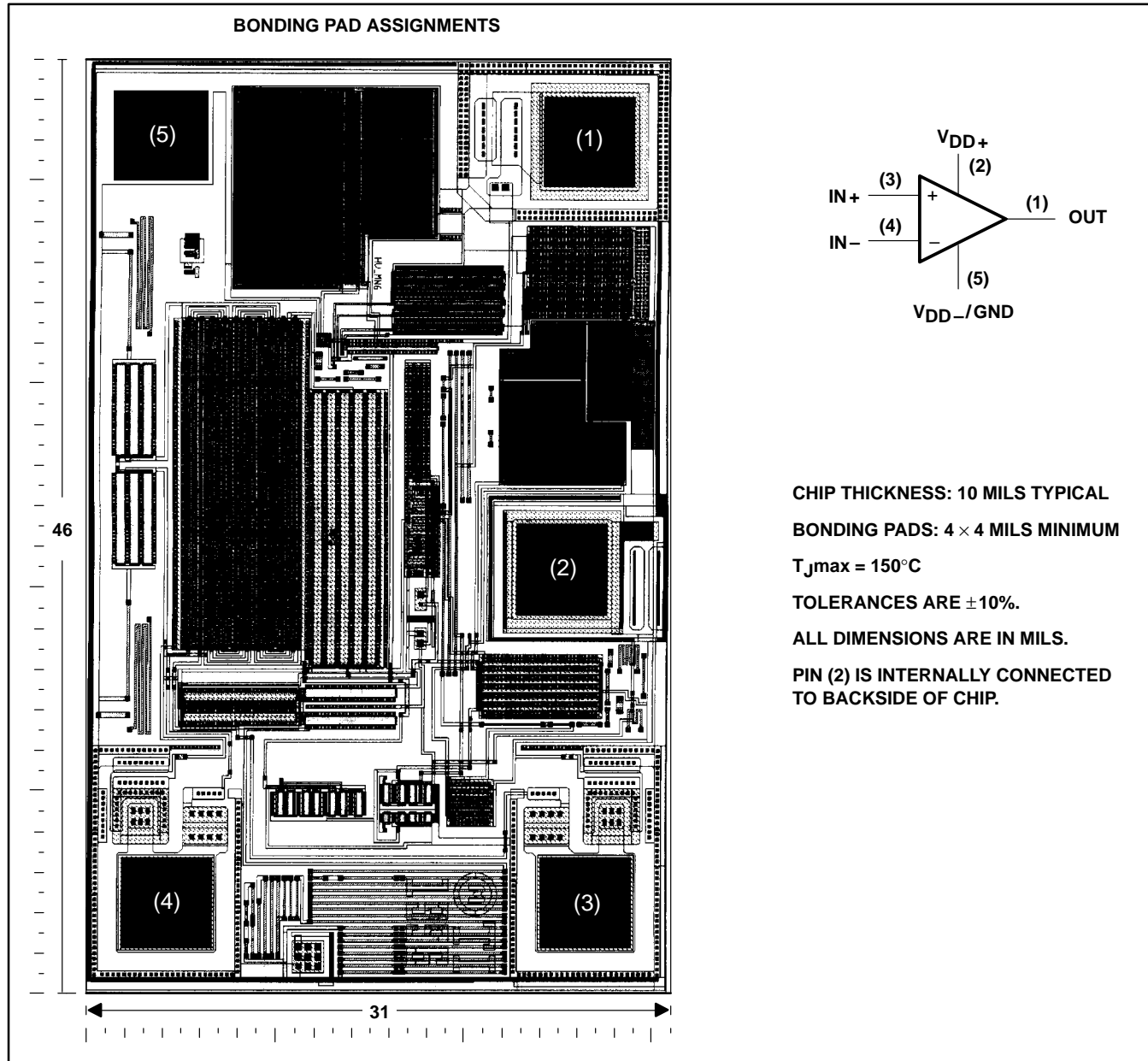
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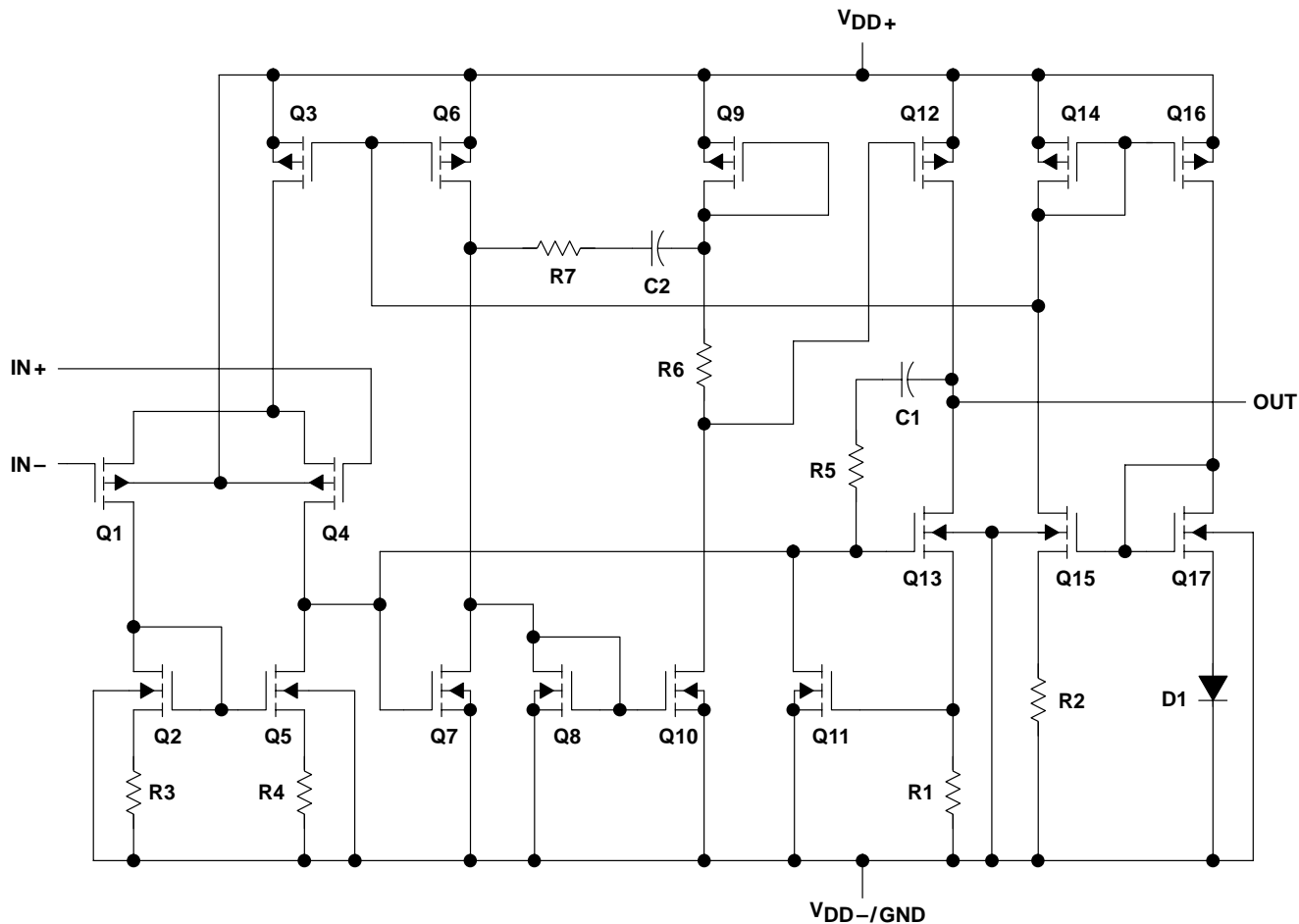
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**TLV2731Y chip information**

This chip, when properly assembled, displays characteristics similar to the TLV2731C. Thermal compression or ultrasonic bonding may be used on the doped-aluminum bonding pads. This chip may be mounted with conductive epoxy or a gold-silicon preform.



equivalent schematic



COMPONENT COUNT†	
Transistors	23
Diodes	5
Resistors	11
Capacitors	2

† Includes both amplifiers and all ESD, bias, and trim circuitry

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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage, $V_{DD}$ (see Note 1)	12 V
Differential input voltage, $V_{ID}$ (see Note 2)	$\pm V_{DD}$
Input voltage range, $V_I$ (any input, see Note 1)	-0.3 V to $V_{DD}$
Input current, $I_I$ (each input)	$\pm 5$ mA
Output current, $I_O$	$\pm 50$ mA
Total current into $V_{DD+}$	$\pm 50$ mA
Total current out of $V_{DD-}$	$\pm 50$ mA
Duration of short-circuit current (at or below) 25°C (see Note 3)	unlimited
Continuous total power dissipation	See Dissipation Rating Table
Operating free-air temperature range, $T_A$ : TLV2731C	0°C to 70°C
TLV2731I	-40°C to 85°C
Storage temperature range, $T_{stg}$	-65°C to 150°C
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds: DBV package	260°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values, except differential voltages, are with respect to  $V_{DD-}$ .  
 2. Differential voltages are at the noninverting input with respect to the inverting input. Excessive current flows when input is brought below  $V_{DD-} - 0.3$  V.  
 3. The output may be shorted to either supply. Temperature and/or supply voltages must be limited to ensure that the maximum dissipation rating is not exceeded.

**DISSIPATION RATING TABLE**

PACKAGE	$T_A \leq 25^\circ\text{C}$ POWER RATING	DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$	$T_A = 70^\circ\text{C}$ POWER RATING	$T_A = 85^\circ\text{C}$ POWER RATING
DBV	150 mW	1.2 mW/°C	96 mW	78 mW

**recommended operating conditions**

	TLV2731C		TLV2731I		UNIT
	MIN	MAX	MIN	MAX	
Supply voltage, $V_{DD}$ (see Note 1)	2.7	10	2.7	10	V
Input voltage range, $V_I$	$V_{DD-}$	$V_{DD+} - 1.3$	$V_{DD-}$	$V_{DD+} - 1.3$	V
Common-mode input voltage, $V_{IC}$	$V_{DD-}$	$V_{DD+} - 1.3$	$V_{DD-}$	$V_{DD+} - 1.3$	V
Operating free-air temperature, $T_A$	0	70	-40	85	°C

NOTE 1: All voltage values, except differential voltages, are with respect to  $V_{DD-}$ .



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**electrical characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2731C			TLV2731I			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_{IO}$	Input offset voltage	Full range		0.7	3		0.7	3	mV
$\alpha V_{IO}$	Temperature coefficient of input offset voltage			0.5		0.5			$\mu\text{V}/^\circ\text{C}$
	Input offset voltage long-term drift (see Note 4)		25°C	0.003		0.003			$\mu\text{V}/\text{mo}$
$I_{IO}$	Input offset current	25°C	0.5		60			pA	
		Full range			150				
$I_{IB}$	Input bias current	25°C	1		60			pA	
		Full range			150				
$V_{ICR}$	Common-mode input voltage range	25°C	0 to 2	-0.3 to 2.2	0 to 2	-0.3 to 2.2		V	
		Full range	0 to 1.7		0 to 1.7				
$V_{OH}$	High-level output voltage	25°C	$I_{OH} = -1\text{ mA}$		2.87			V	
		25°C	$I_{OH} = -2\text{ mA}$		2.74				
		Full range			2.3				
$V_{OL}$	Low-level output voltage	25°C	$V_{IC} = 1.5\text{ V}$	$I_{OL} = 50\ \mu\text{A}$		10		mV	
		25°C	$V_{IC} = 1.5\text{ V}$	$I_{OL} = 500\ \mu\text{A}$		100			
		Full range			300		300		
$A_{VD}$	Large-signal differential voltage amplification	25°C	$V_{IC} = 1.5\text{ V}$ , $V_O = 1\text{ V to }2\text{ V}$	$R_L = 600\ \Omega$ ‡	1	1.6	1	1.6	V/mV
				Full range	0.3		0.3		
				$R_L = 1\ \text{M}\Omega$ ‡	250		250		
$r_{id}$	Differential input resistance	25°C			$10^{12}$			$\Omega$	
$r_{ic}$	Common-mode input resistance	25°C			$10^{12}$			$\Omega$	
$c_{ic}$	Common-mode input capacitance	25°C	$f = 10\text{ kHz}$		6			pF	
$z_o$	Closed-loop output impedance	25°C	$f = 1\text{ MHz}$ , $A_V = 1$		156			$\Omega$	
CMRR	Common-mode rejection ratio	25°C	$V_{IC} = 0\text{ to }1.7\text{ V}$ , $V_O = 1.5\text{ V}$ , $R_S = 50\ \Omega$		60 70		60 70	dB	
		Full range			55				
kSVR	Supply voltage rejection ratio ( $\Delta V_{DD} / \Delta V_{IO}$ )	25°C	$V_{DD} = 2.7\text{ V to }8\text{ V}$ , $V_{IC} = V_{DD}/2$ , No load		70 96		70 96	dB	
		Full range			70				
$I_{DD}$	Supply current	25°C	$V_O = 1.5\text{ V}$ , No load		750	1200	750 1200	$\mu\text{A}$	
		Full range			1500		1500		

† Full range for the TLV2731C is 0°C to 70°C. Full range for the TLV2731I is -40°C to 85°C.

‡ Referenced to 1.5 V

NOTE 4: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.

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**operating characteristics at specified free-air temperature,  $V_{DD} = 3\text{ V}$**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2731C			TLV2731I			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain $V_O = 1.1\text{ V to }1.9\text{ V}, R_L = 600\ \Omega\ddagger, C_L = 100\text{ pF}\ddagger$	25°C	0.75	1.25		0.75	1.25		V/ $\mu\text{s}$
		Full range	0.5			0.5			
$V_n$	Equivalent input noise voltage $f = 10\text{ Hz}$ $f = 1\text{ kHz}$	25°C	105			105			nV/ $\sqrt{\text{Hz}}$
		25°C	16			16			
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage $f = 0.1\text{ Hz to }1\text{ Hz}$ $f = 0.1\text{ Hz to }10\text{ Hz}$	25°C	1.4			1.4			$\mu\text{V}$
		25°C	1.5			1.5			
$I_n$	Equivalent input noise current	25°C	0.6			0.6			fA/ $\sqrt{\text{Hz}}$
THD+N	$V_O = 1\text{ V to }2\text{ V}, f = 20\text{ kHz}, R_L = 600\ \Omega\ddagger$	$A_V = 1$	0.285%			0.285%			
		$A_V = 10$	7.2%			7.2%			
	$V_O = 1\text{ V to }2\text{ V}, f = 20\text{ kHz}, R_L = 600\ \Omega\§$	$A_V = 1$	0.014%			0.014%			
		$A_V = 10$	0.098%			0.098%			
		$A_V = 100$	0.13%			0.13%			
Gain-bandwidth product	$f = 10\text{ kHz}, C_L = 100\text{ pF}\ddagger, R_L = 600\ \Omega\ddagger$	25°C	1.9			1.9			MHz
BOM	Maximum output-swing bandwidth $V_{O(PP)} = 1\text{ V}, R_L = 600\ \Omega\ddagger, A_V = 1, C_L = 100\text{ pF}\ddagger$	25°C	60			60			kHz
$t_s$	Settling time $A_V = -1, \text{ Step} = 1\text{ V to }2\text{ V}, R_L = 600\ \Omega\ddagger, C_L = 100\text{ pF}\ddagger$	To 0.1%	0.9			0.9			$\mu\text{s}$
		To 0.01%	1.5			1.5			
$\phi_m$	Phase margin at unity gain $R_L = 600\ \Omega\ddagger, C_L = 100\text{ pF}\ddagger$	25°C	50°			50°			
		25°C	8			8			
	Gain margin	25°C	8			8			dB

† Full range is  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

‡ Referenced to 1.5 V

§ Referenced to 0 V



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**electrical characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2731C			TLV2731I			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
$V_{IO}$ Input offset voltage	$V_{DD} = \pm 2.5\text{ V}$ , $V_O = 0$ , $V_{IC} = 0$ , $R_S = 50\ \Omega$	Full range	0.7		3	0.7		3	mV
$\alpha_{V_{IO}}$ Temperature coefficient of input offset voltage			0.5		0.5		$\mu\text{V}/^\circ\text{C}$		
Input offset voltage long-term drift (see Note 4)		25°C	0.003		0.003		$\mu\text{V}/\text{mo}$		
$I_{IO}$ Input offset current		25°C	0.5	60	0.5	60	pA		
		Full range	150		150				
$I_{IB}$ Input bias current	25°C	1	60	1	60	pA			
	Full range	150		150					
$V_{ICR}$ Common-mode input voltage range	$R_S = 50\ \Omega$ , $ V_{IO}  \leq 5\text{ mV}$	25°C	0 to 4	-0.3 to 4.2	0 to 4	-0.3 to 4.2	V		
		Full range	0 to 3.7		0 to 3.7				
$V_{OH}$ High-level output voltage	$I_{OH} = -1\text{ mA}$	25°C	4.9		4.9		V		
		25°C	4.6		4.6				
		Full range	4.3		4.3				
$V_{OL}$ Low-level output voltage	$V_{IC} = 2.5\text{ V}$ , $I_{OL} = 500\ \mu\text{A}$	25°C	80		80		mV		
		25°C	160		160				
		Full range	500		500				
$A_{VD}$ Large-signal differential voltage amplification	$V_{IC} = 2.5\text{ V}$ , $V_O = 1\text{ V to }4\text{ V}$	25°C	$R_L = 600\ \Omega$ ‡		1 1.5		V/mV		
			Full range		0.3				
		25°C	$R_L = 1\ \text{M}\Omega$ ‡		400				
$r_{id}$ Differential input resistance		25°C	$10^{12}$		$10^{12}$		$\Omega$		
$r_{ic}$ Common-mode input resistance		25°C	$10^{12}$		$10^{12}$		$\Omega$		
$c_{ic}$ Common-mode input capacitance	$f = 10\text{ kHz}$	25°C	6		6		pF		
$z_o$ Closed-loop output impedance	$f = 1\text{ MHz}$ , $A_V = 1$	25°C	138		138		$\Omega$		
CMRR Common-mode rejection ratio	$V_{IC} = 0\text{ to }2.7\text{ V}$ , $V_O = 2.5\text{ V}$ , $R_S = 50\ \Omega$	25°C	60	70	60	70	dB		
		Full range	55		55				
$k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{DD} / \Delta V_{IO}$ )	$V_{DD} = 4.4\text{ V to }8\text{ V}$ , $V_{IC} = V_{DD}/2$ , No load	25°C	70	96	70	96	dB		
		Full range	70		70				
$I_{DD}$ Supply current	$V_O = 2.5\text{ V}$ , No load	25°C	850	1300	850	1300	$\mu\text{A}$		
		Full range	1600		1600				

† Full range for the TLV2731C is 0°C to 70°C. Full range for the TLV2731I is -40°C to 85°C.

‡ Referenced to 2.5 V

NOTE 5: Typical values are based on the input offset voltage shift observed through 500 hours of operating life test at  $T_A = 150^\circ\text{C}$  extrapolated to  $T_A = 25^\circ\text{C}$  using the Arrhenius equation and assuming an activation energy of 0.96 eV.

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**operating characteristics at specified free-air temperature,  $V_{DD} = 5\text{ V}$**

PARAMETER	TEST CONDITIONS	$T_A$ †	TLV2731C			TLV2731I			UNIT
			MIN	TYP	MAX	MIN	TYP	MAX	
SR	Slew rate at unity gain $V_O = 1.5\text{ V to }3.5\text{ V},$ $R_L = 600\ \Omega\ddagger,$ $C_L = 100\text{ pF}\ddagger$	25°C	1	1.6		1	1.6		V/ $\mu\text{s}$
		Full range	0.7			0.7			
$V_n$	Equivalent input noise voltage	f = 10 Hz		100			100		nV/ $\sqrt{\text{Hz}}$
		f = 1 kHz	25°C		15		15		
$V_{N(PP)}$	Peak-to-peak equivalent input noise voltage	f = 0.1 Hz to 1 Hz	25°C		1.4		1.4		$\mu\text{V}$
		f = 0.1 Hz to 10 Hz	25°C		1.5		1.5		
$I_n$	Equivalent input noise current	25°C		0.6		0.6		fA/ $\sqrt{\text{Hz}}$	
THD+N	Total harmonic distortion plus noise	$V_O = 1.5\text{ V to }3.5\text{ V},$ f = 20 kHz, $R_L = 600\ \Omega\ddagger$	$A_V = 1$	25°C		0.409%		0.409%	
			$A_V = 10$	25°C		3.68%		3.68%	
		$V_O = 1.5\text{ V to }3.5\text{ V},$ f = 20 kHz, $R_L = 600\ \Omega\§$	$A_V = 1$	25°C		0.018%		0.018%	
			$A_V = 10$	25°C		0.045%		0.045%	
			$A_V = 100$	25°C		0.116%		0.116%	
		Gain-bandwidth product	f = 10 kHz, $R_L = 600\ \Omega\ddagger,$ $C_L = 100\text{ pF}\ddagger$	25°C		2		2	
$B_{OM}$	Maximum output-swing bandwidth $V_{O(PP)} = 1\text{ V},$ $R_L = 600\ \Omega\ddagger,$ $A_V = 1,$ $C_L = 100\text{ pF}\ddagger$	25°C		300		300		kHz	
$t_s$	Settling time $A_V = -1,$ Step = 1.5 V to 3.5 V, $R_L = 600\ \Omega\ddagger,$ $C_L = 100\text{ pF}\ddagger$	To 0.1%	25°C		0.95		0.95	$\mu\text{s}$	
		To 0.01%	25°C		2.4		2.4		
$\phi_m$	Phase margin at unity gain $R_L = 600\ \Omega\ddagger,$ $C_L = 100\text{ pF}\ddagger$	25°C		48°		48°		dB	
		Gain margin	25°C		8		8		

† Full range is  $-40^\circ\text{C}$  to  $85^\circ\text{C}$ .

‡ Referenced to 2.5 V

§ Referenced to 0 V





**electrical characteristics at  $V_{DD} = 3\text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	TLV2731Y			UNIT
		MIN	TYP	MAX	
$V_{IO}$ Input offset voltage	$V_{DD} \pm \pm 1.5\text{ V}$ , $R_S = 50\ \Omega$	750			$\mu\text{V}$
$I_{IO}$ Input offset current		0.5 60			$\text{pA}$
$I_{IB}$ Input bias current		1 60			$\text{pA}$
$V_{ICR}$ Common-mode input voltage range	$ V_{IO}  \leq 5\text{ mV}$ , $R_S = 50\ \Omega$	-0.3 to 2.2			$\text{V}$
$V_{OH}$ High-level output voltage	$I_{OH} = -1\text{ mA}$	2.87			$\text{V}$
$V_{OL}$ Low-level output voltage	$V_{IC} = 1.5\text{ V}$ , $I_{OL} = 50\ \mu\text{A}$	10			$\text{mV}$
	$V_{IC} = 1.5\text{ V}$ , $I_{OL} = 500\ \mu\text{A}$	100			
$A_{VD}$ Large-signal differential voltage amplification	$V_O = 1\text{ V to }2\text{ V}$	$R_L = 600\ \Omega^\dagger$	1.6		$\text{V/mV}$
		$R_L = 1\ \text{M}\Omega^\dagger$	250		
$r_{id}$ Differential input resistance		$10^{12}$			$\Omega$
$r_{ic}$ Common-mode input resistance		$10^{12}$			$\Omega$
$c_{ic}$ Common-mode input capacitance	$f = 10\text{ kHz}$	6			$\text{pF}$
$z_o$ Closed-loop output impedance	$f = 1\text{ MHz}$ , $A_V = 1$	156			$\Omega$
CMRR Common-mode rejection ratio	$V_{IC} = 0\text{ to }1.7\text{ V}$ , $V_O = 0$ , $R_S = 50\ \Omega$	70			$\text{dB}$
$k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ )	$V_{DD} = 2.7\text{ V to }8\text{ V}$ , $V_{IC} = 0$ , No load	96			$\text{dB}$
$I_{DD}$ Supply current	$V_O = 0$ , No load	750			$\mu\text{A}$

† Referenced to 1.5 V

**electrical characteristics at  $V_{DD} = 5\text{ V}$ ,  $T_A = 25^\circ\text{C}$  (unless otherwise noted)**

PARAMETER	TEST CONDITIONS	TLV2731Y			UNIT
		MIN	TYP	MAX	
$V_{IO}$ Input offset voltage	$V_{DD} \pm \pm 1.5\text{ V}$ , $R_S = 50\ \Omega$	710			$\mu\text{V}$
$I_{IO}$ Input offset current		0.5 60			$\text{pA}$
$I_{IB}$ Input bias current		1 60			$\text{pA}$
$V_{ICR}$ Common-mode input voltage range	$ V_{IO}  \leq 5\text{ mV}$ , $R_S = 50\ \Omega$	-0.3 to 4.2			$\text{V}$
$V_{OH}$ High-level output voltage	$I_{OH} = -1\text{ mA}$	4.9			$\text{V}$
$V_{OL}$ Low-level output voltage	$V_{IC} = 2.5\text{ V}$ , $I_{OL} = 500\ \mu\text{A}$	80			$\text{mV}$
	$V_{IC} = 2.5\text{ V}$ , $I_{OL} = 1\text{ mA}$	160			
$A_{VD}$ Large-signal differential voltage amplification	$V_O = 1\text{ V to }2\text{ V}$	$R_L = 600\ \Omega^\dagger$	15		$\text{V/mV}$
		$R_L = 1\ \text{M}\Omega^\dagger$	400		
$r_{id}$ Differential input resistance		$10^{12}$			$\Omega$
$r_{ic}$ Common-mode input resistance		$10^{12}$			$\Omega$
$c_{ic}$ Common-mode input capacitance	$f = 10\text{ kHz}$	6			$\text{pF}$
$z_o$ Closed-loop output impedance	$f = 1\text{ MHz}$ , $A_V = 1$	138			$\Omega$
CMRR Common-mode rejection ratio	$V_{IC} = 0\text{ to }1.7\text{ V}$ , $V_O = 0$ , $R_S = 50\ \Omega$	70			$\text{dB}$
$k_{SVR}$ Supply voltage rejection ratio ( $\Delta V_{DD}/\Delta V_{IO}$ )	$V_{DD} = 2.7\text{ V to }8\text{ V}$ , $V_{IC} = 0$ , No load	96			$\text{dB}$
$I_{DD}$ Supply current	$V_O = 0$ , No load	850			$\mu\text{A}$

† Referenced to 2.5 V

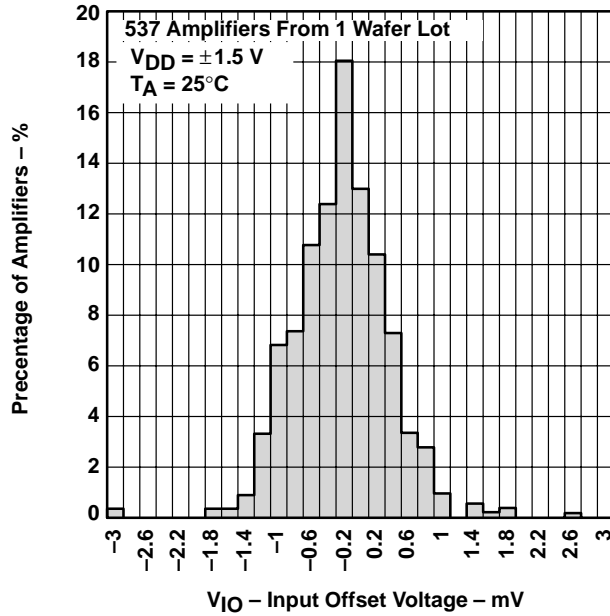
**TYPICAL CHARACTERISTICS**

**Table of Graphs**

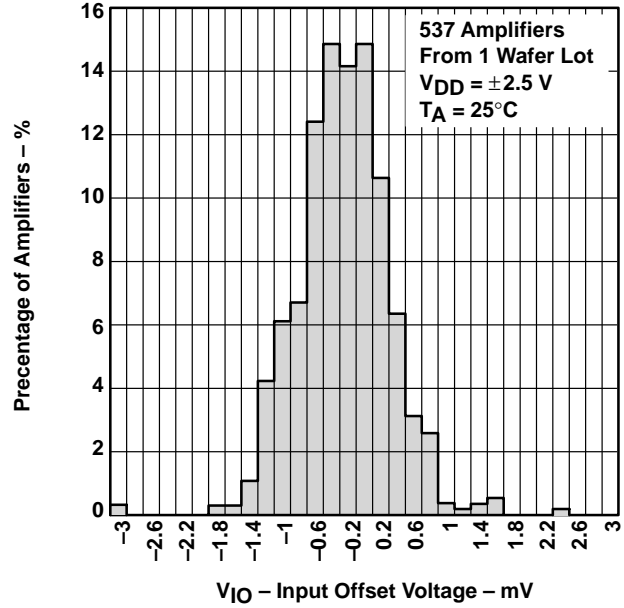
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**TYPICAL CHARACTERISTICS**

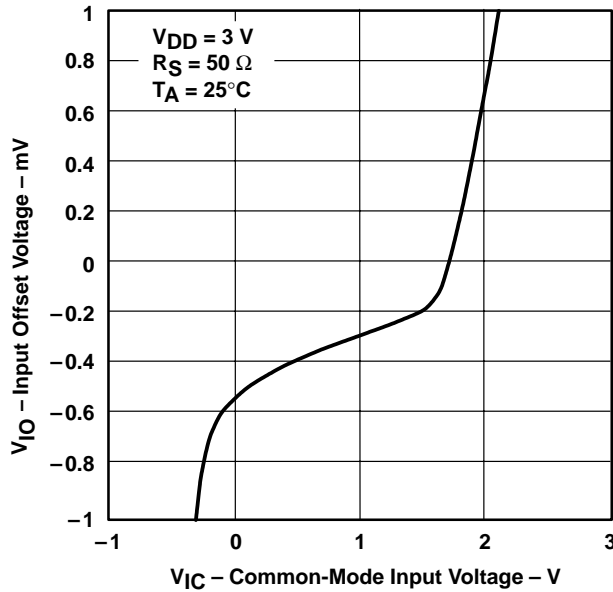
**DISTRIBUTION OF TLV2731  
INPUT OFFSET VOLTAGE**



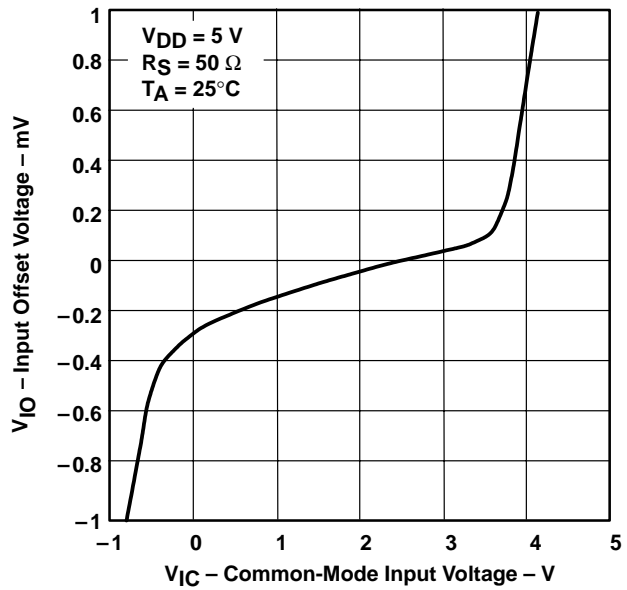
**DISTRIBUTION OF TLV2731  
INPUT OFFSET VOLTAGE**



**INPUT OFFSET VOLTAGE†  
vs  
COMMON-MODE INPUT VOLTAGE**

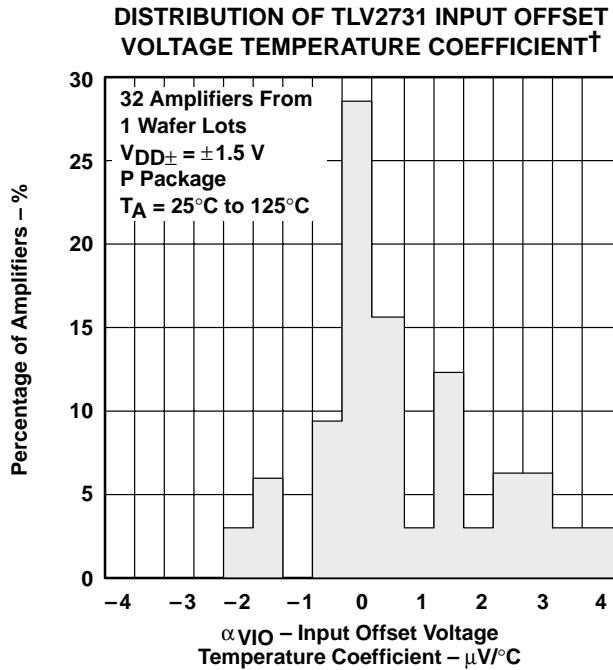


**INPUT OFFSET VOLTAGE†  
vs  
COMMON-MODE INPUT VOLTAGE**

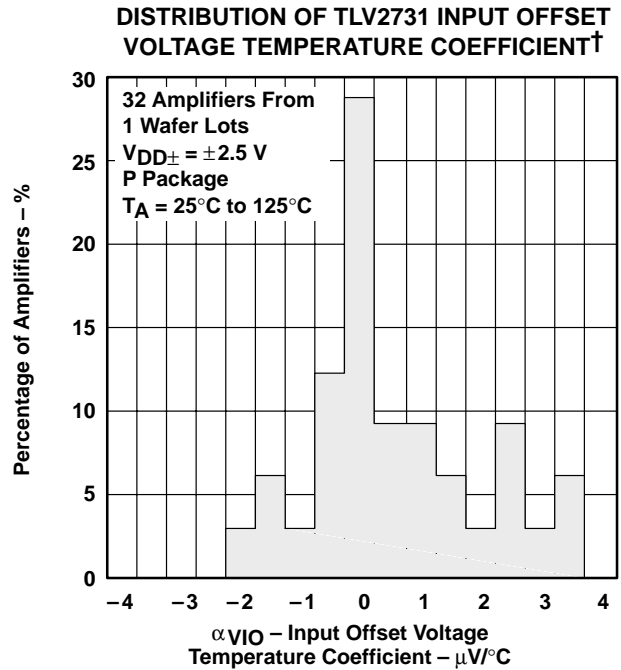


† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

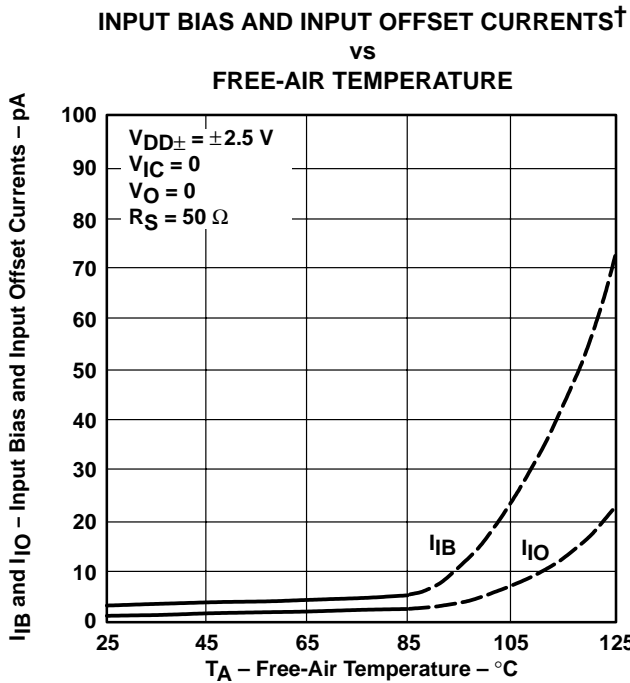
**TYPICAL CHARACTERISTICS**



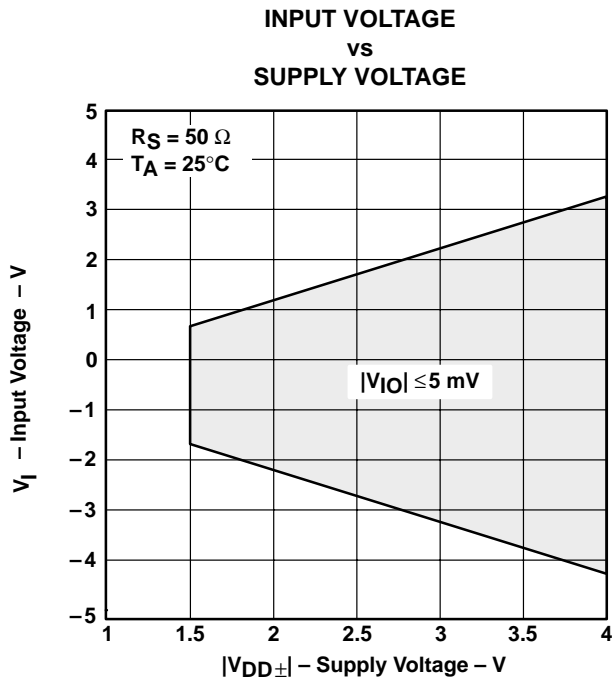
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**Figure 6**



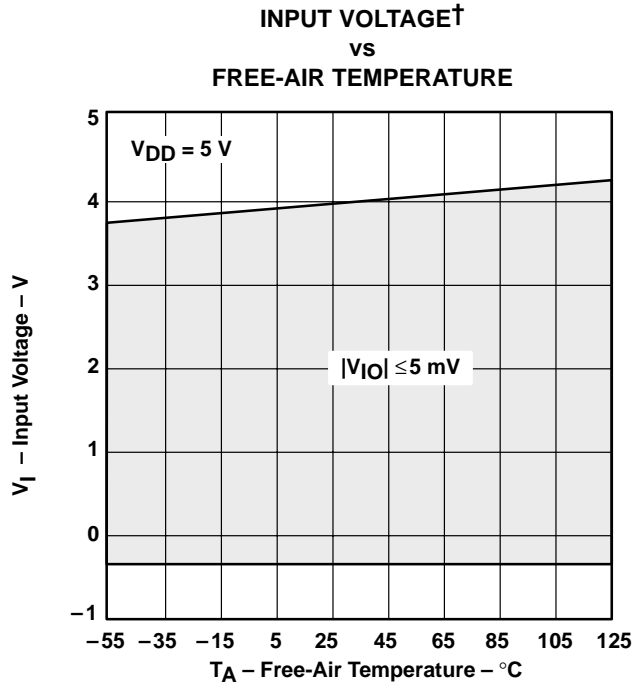
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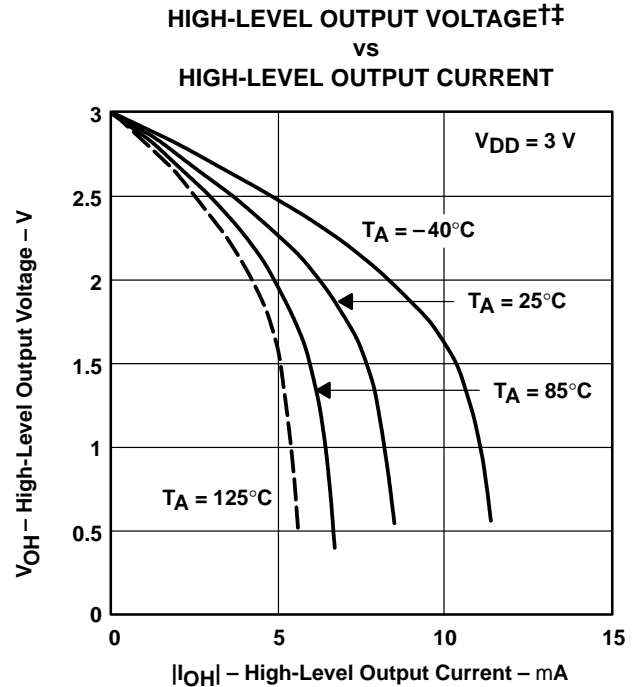
**Figure 8**

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

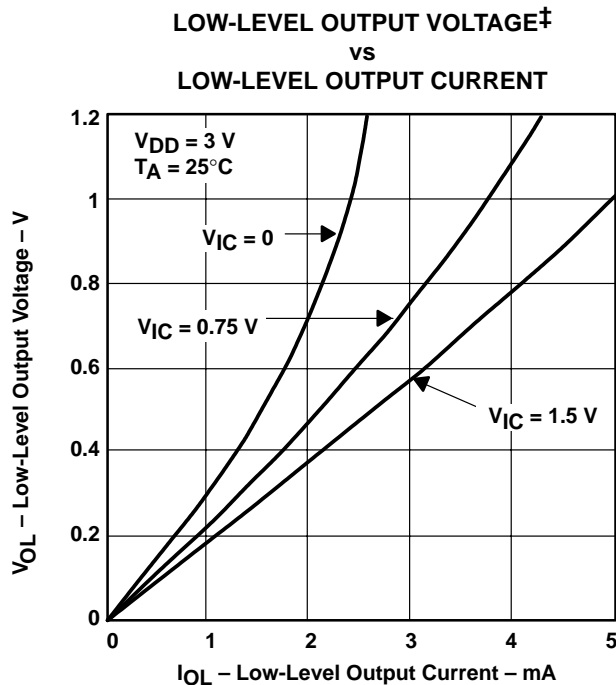
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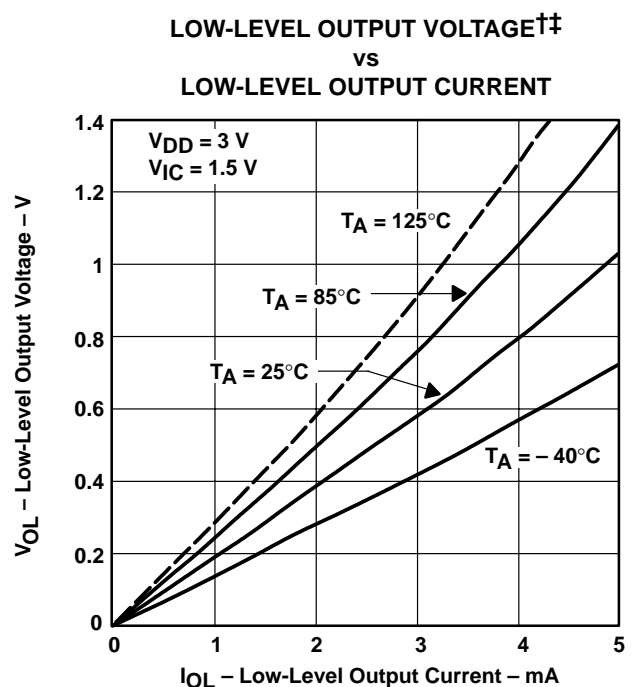
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**Figure 10**



**Figure 11**

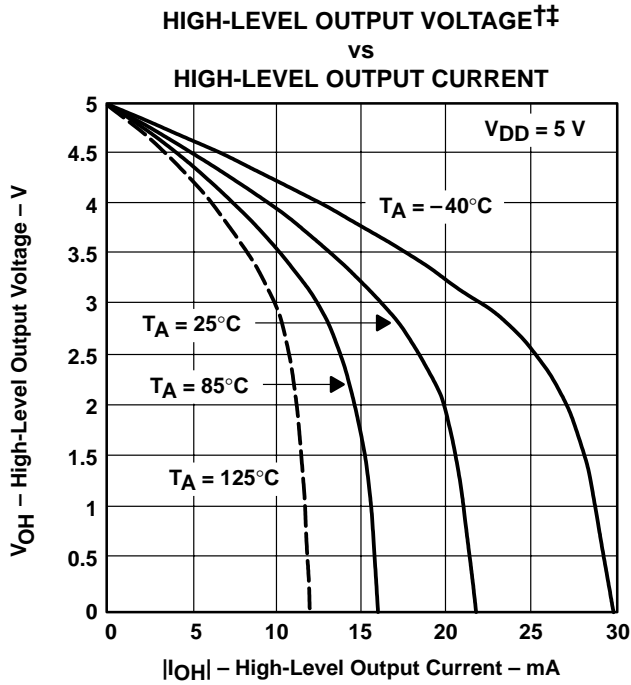


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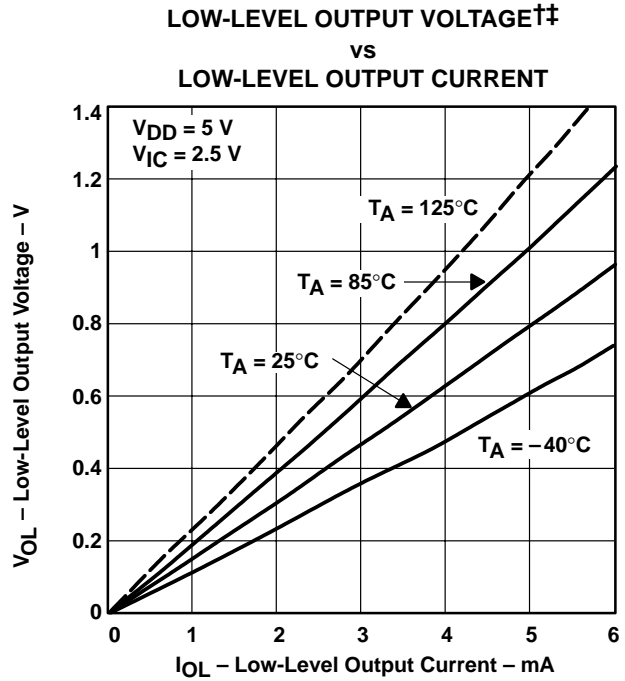
† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

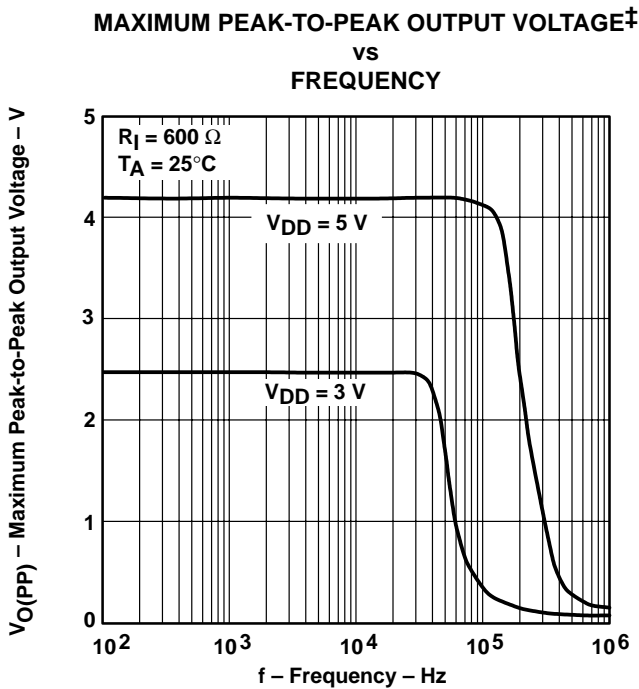
**TYPICAL CHARACTERISTICS**



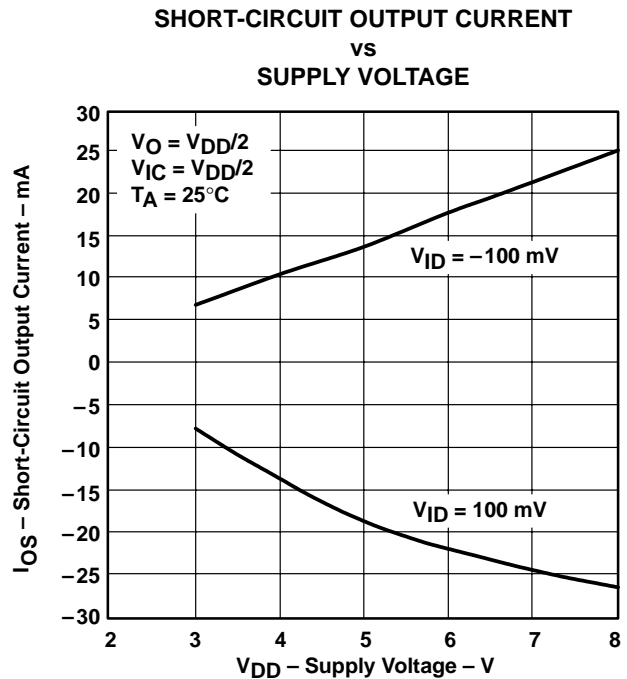
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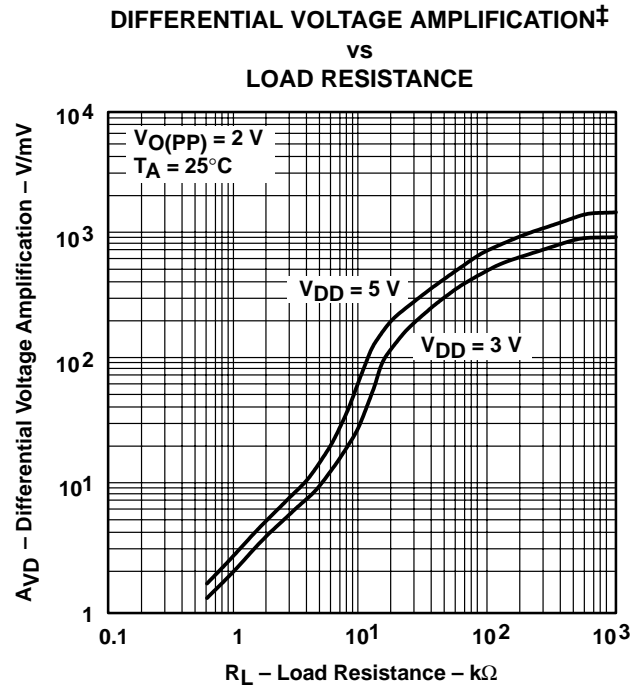
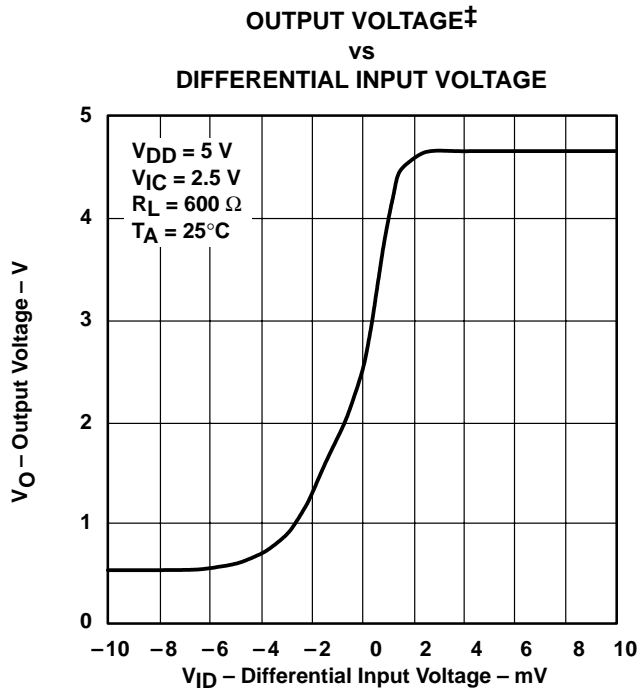
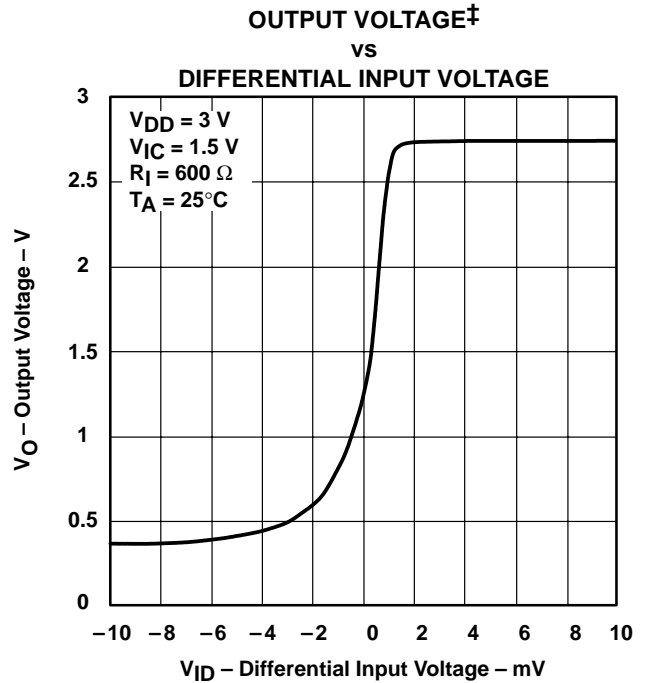
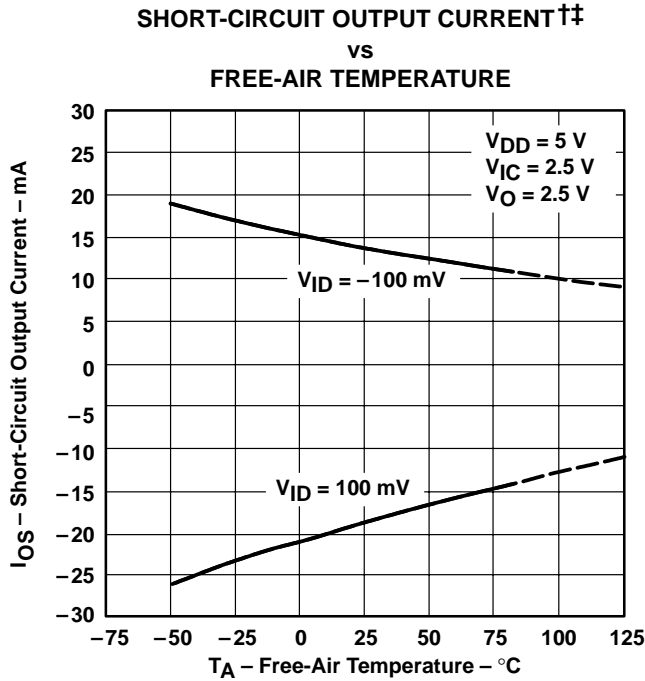
**Figure 15**



**Figure 16**

† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.  
 ‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

**TYPICAL CHARACTERISTICS**



† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.  
 †† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

TYPICAL CHARACTERISTICS

LARGE-SIGNAL DIFFERENTIAL VOLTAGE  
 AMPLIFICATION AND PHASE MARGIN†

vs  
 FREQUENCY

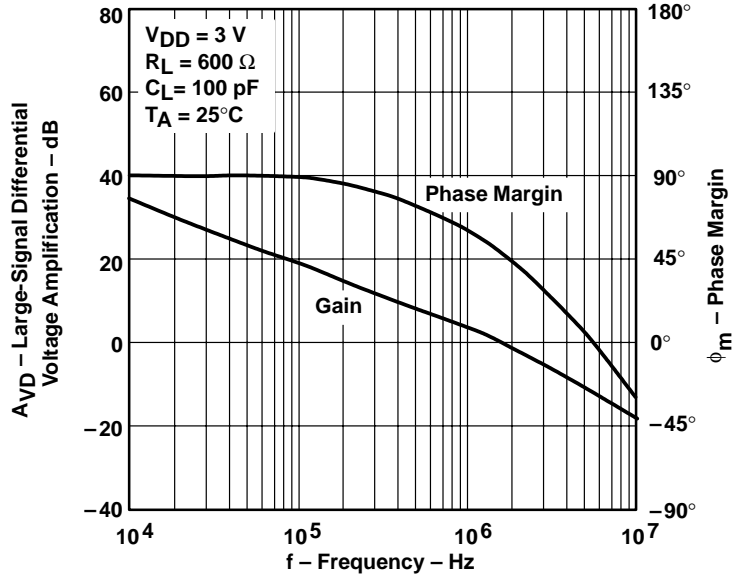


Figure 21

LARGE-SIGNAL DIFFERENTIAL VOLTAGE  
 AMPLIFICATION AND PHASE MARGIN†

vs  
 FREQUENCY

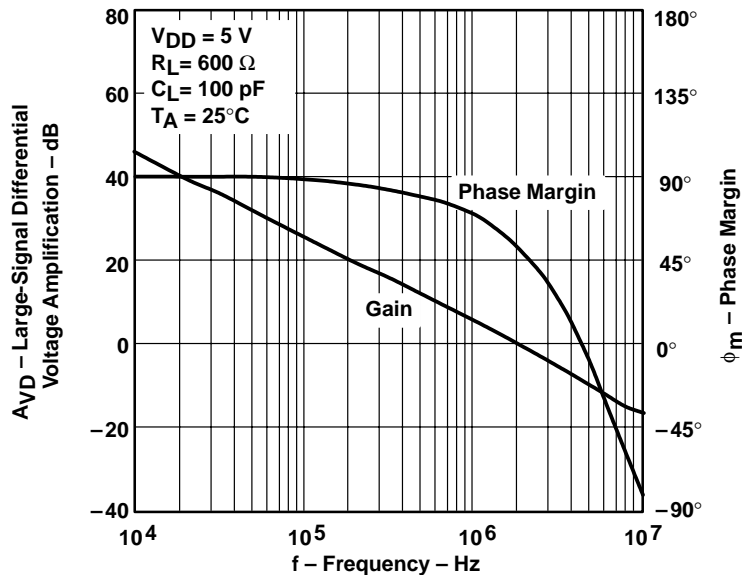
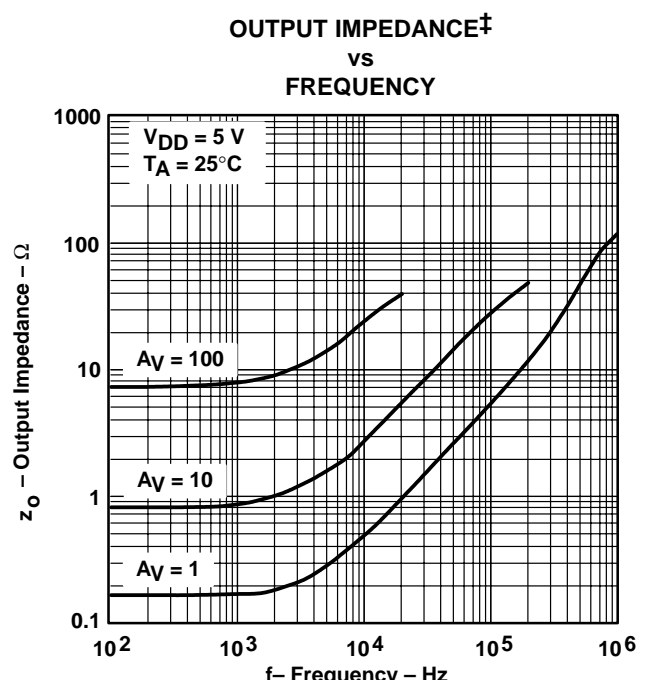
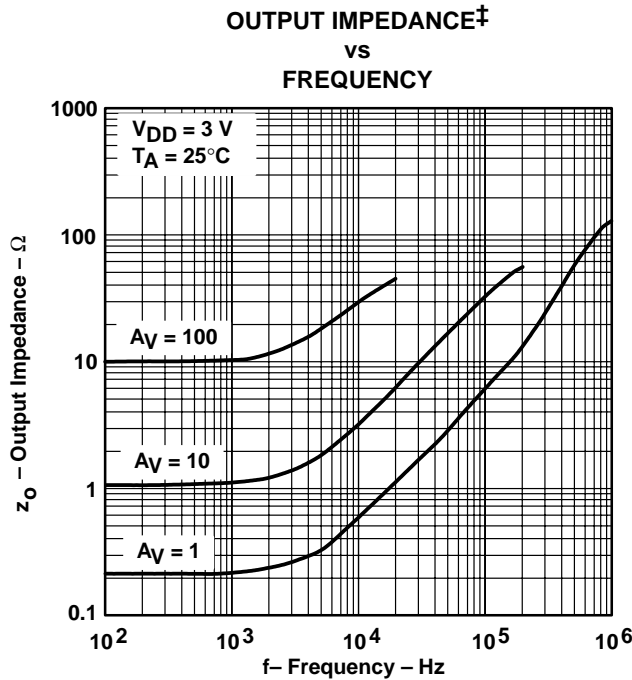
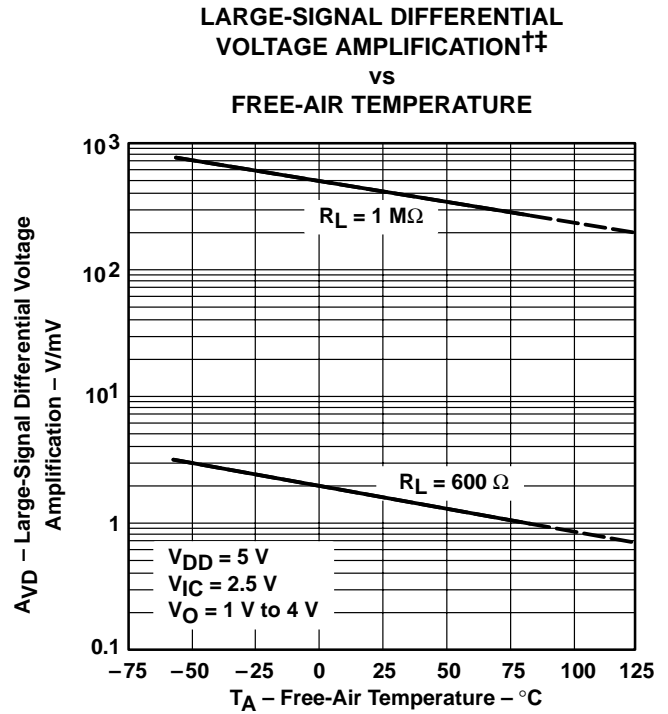
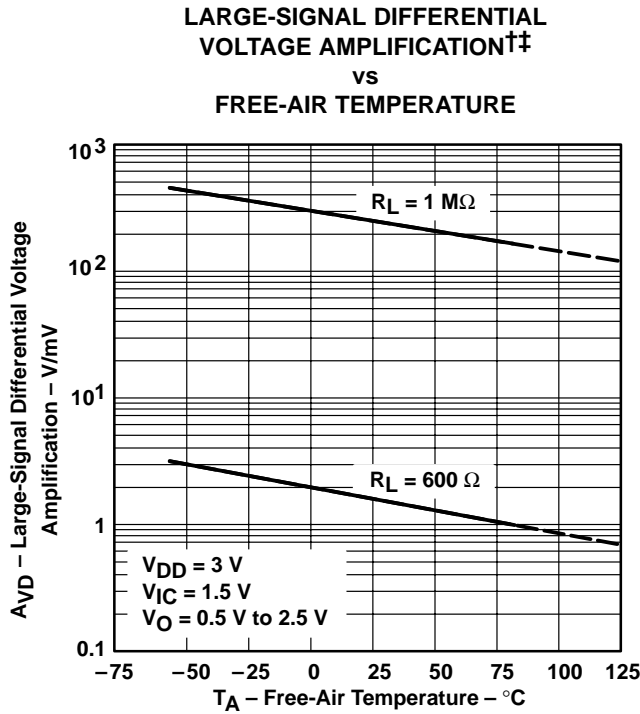


Figure 22

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

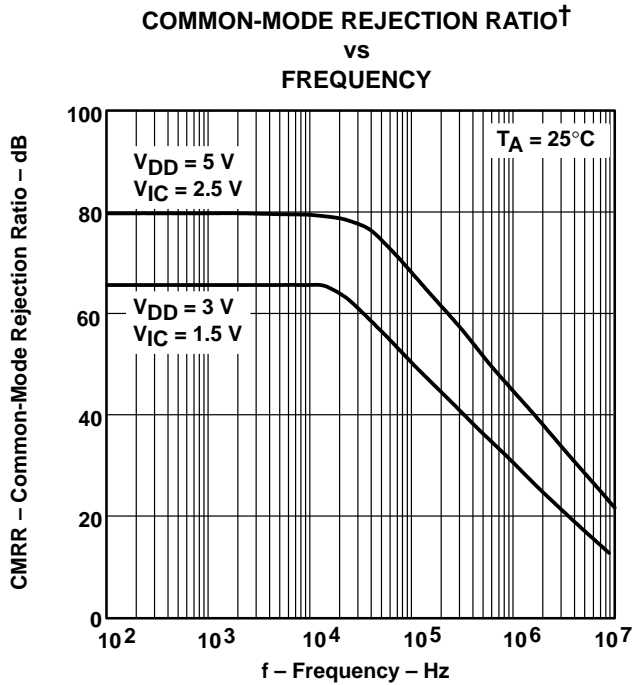


**TYPICAL CHARACTERISTICS**

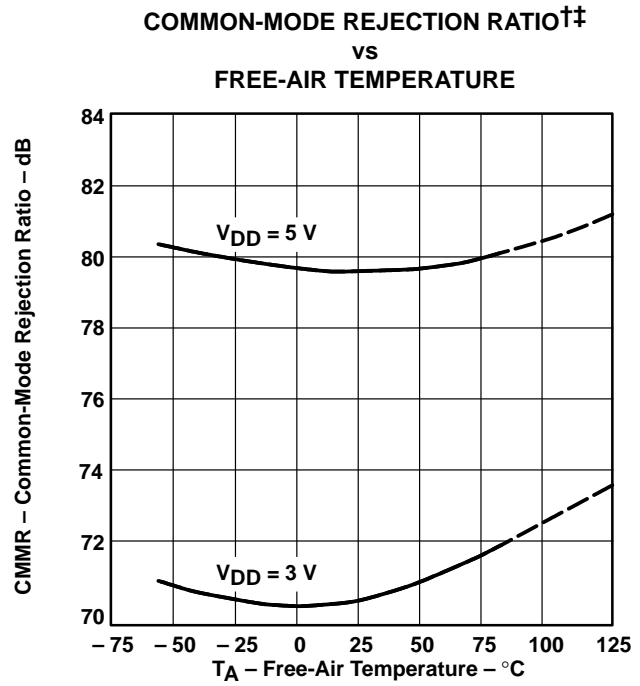


† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.  
 ‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

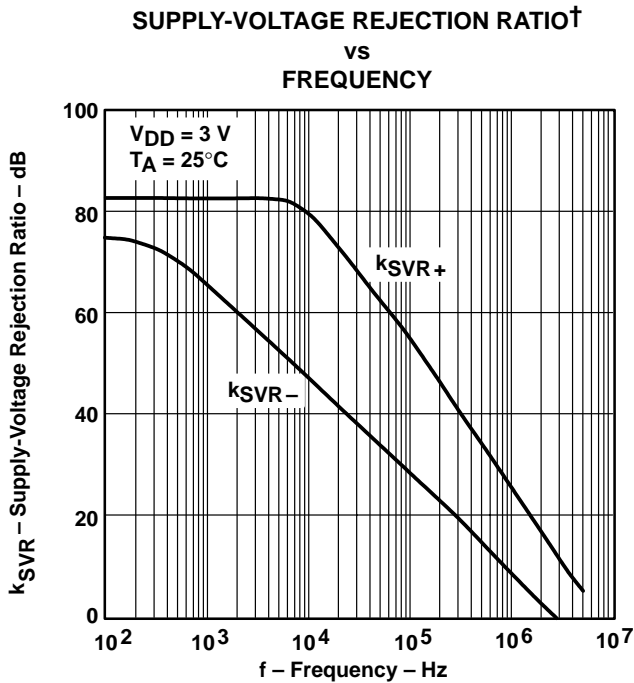
**TYPICAL CHARACTERISTICS**



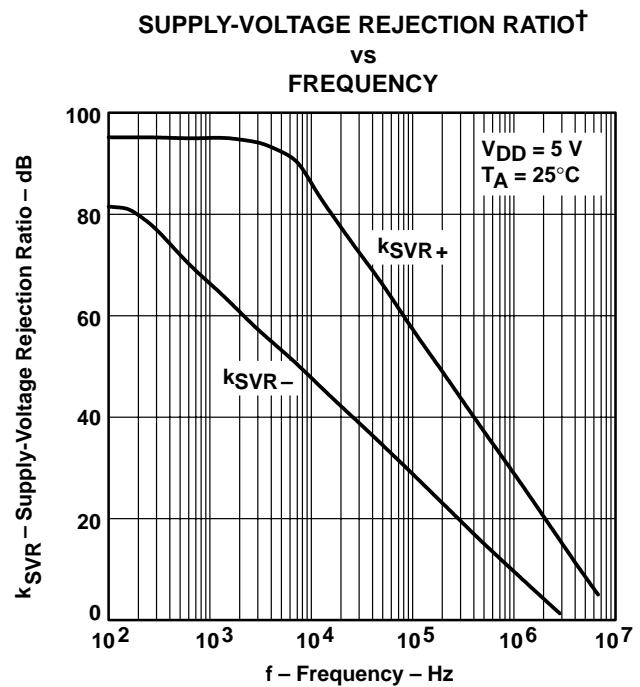
**Figure 27**



**Figure 28**



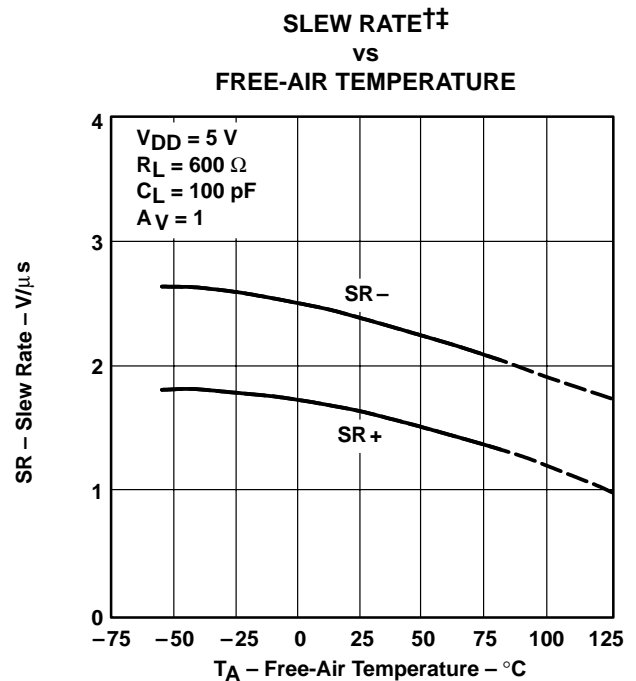
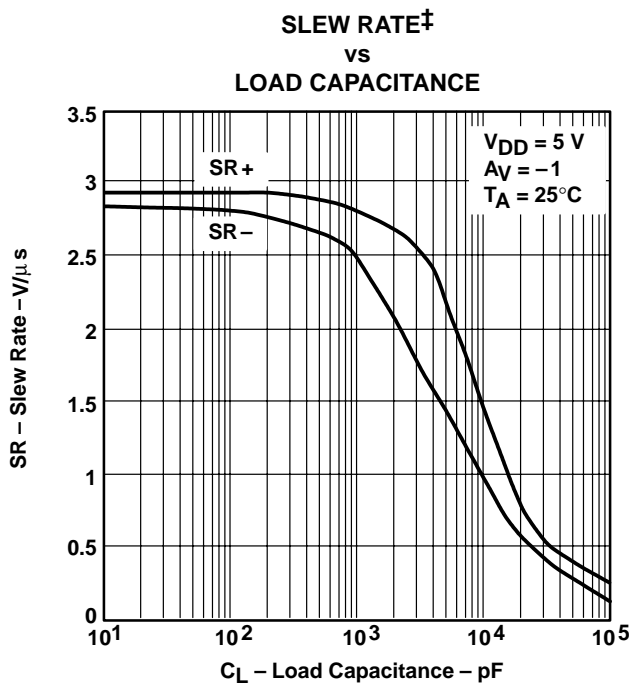
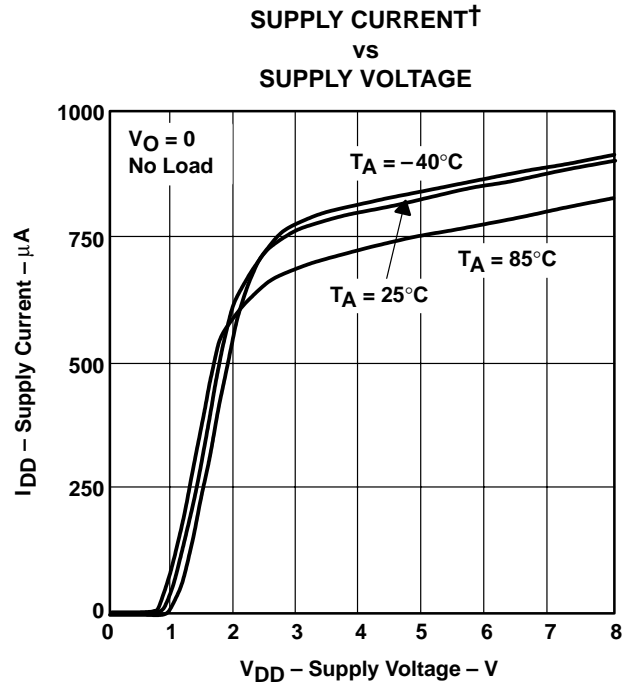
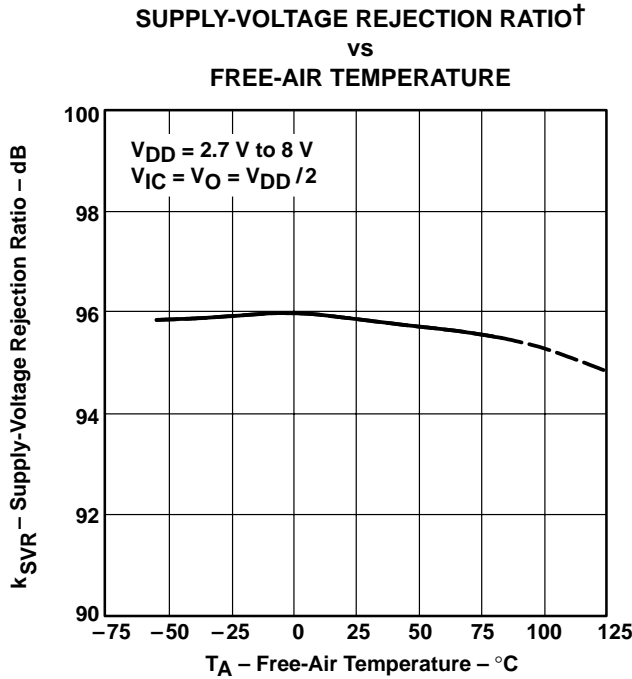
**Figure 29**



**Figure 30**

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.  
 ‡ Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

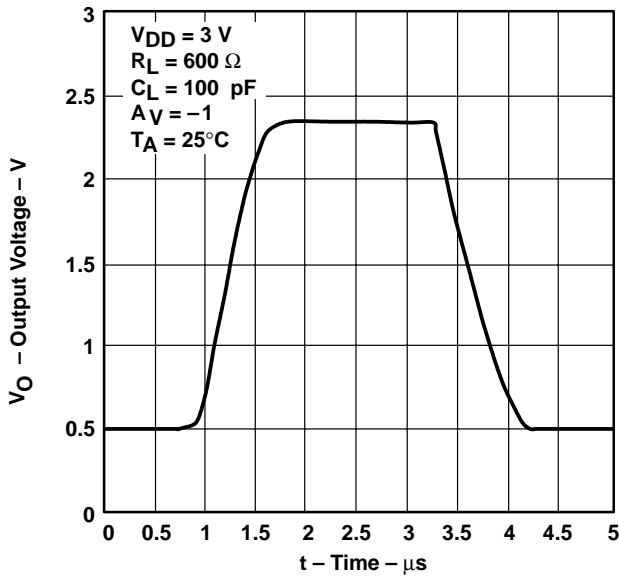
**TYPICAL CHARACTERISTICS**



† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.  
 ‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

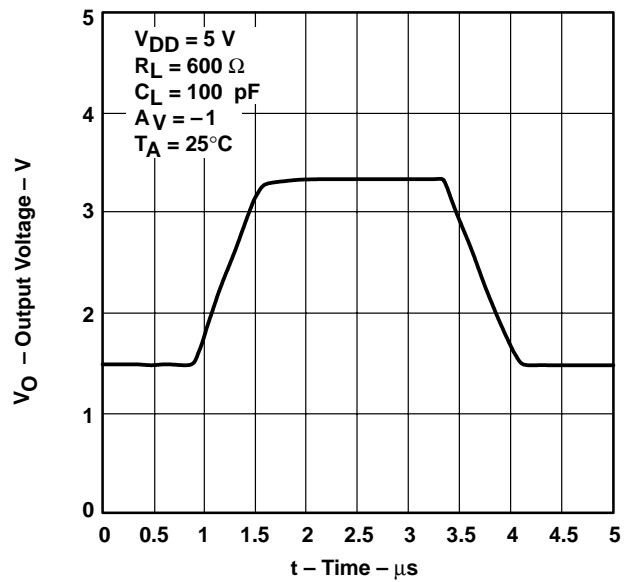
**TYPICAL CHARACTERISTICS**

**INVERTING LARGE-SIGNAL PULSE RESPONSE†**



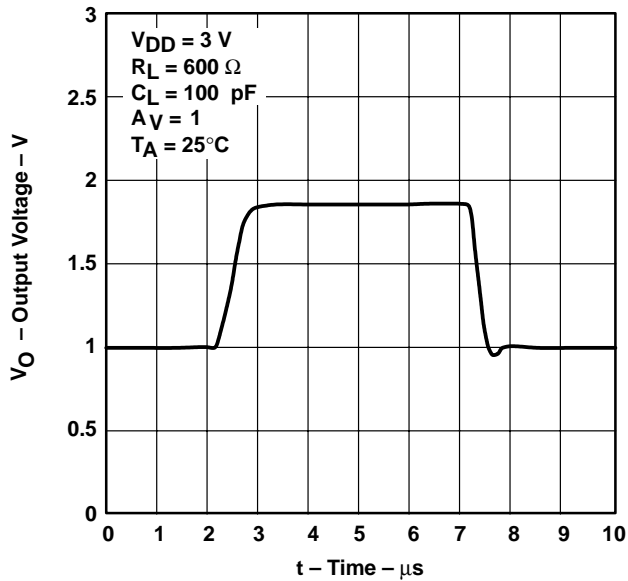
**Figure 35**

**INVERTING LARGE-SIGNAL PULSE RESPONSE†**



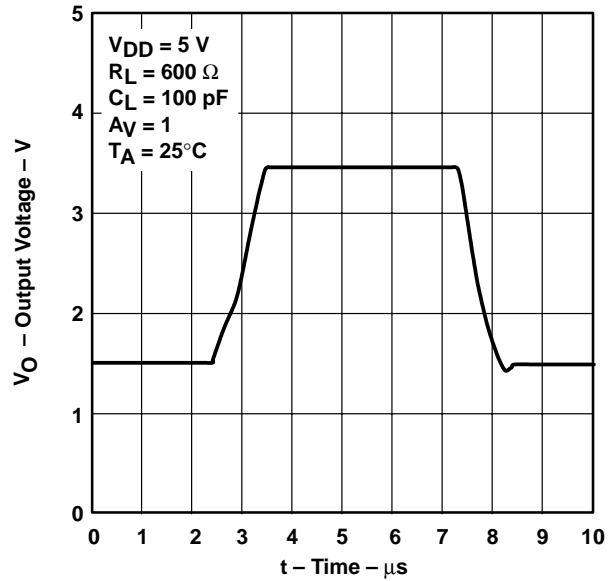
**Figure 36**

**VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE†**



**Figure 37**

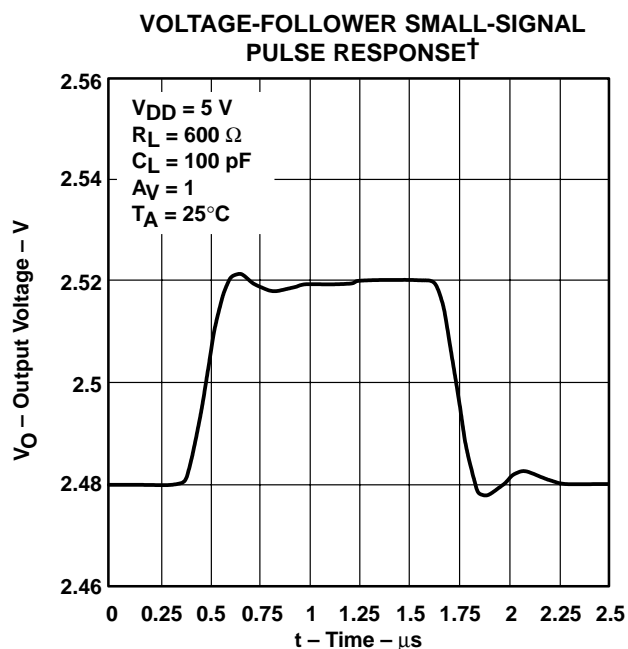
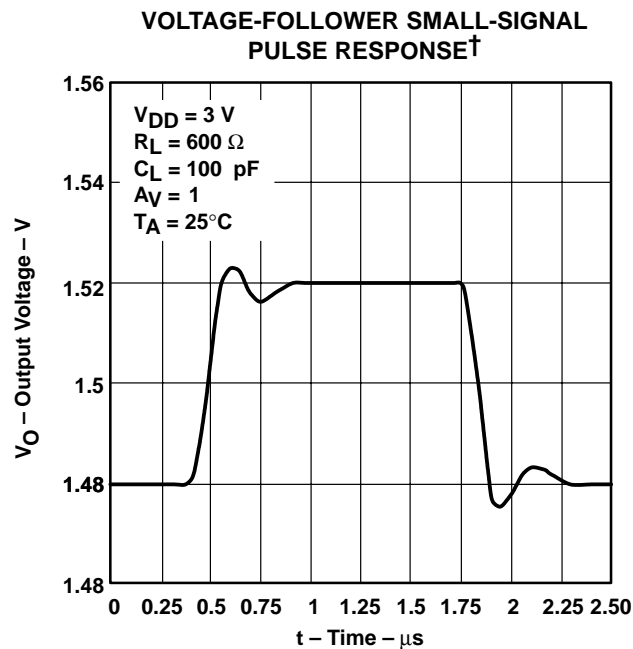
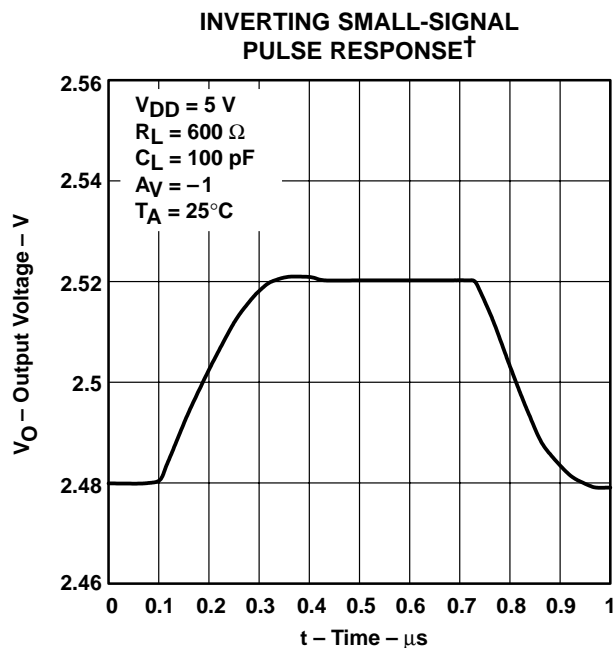
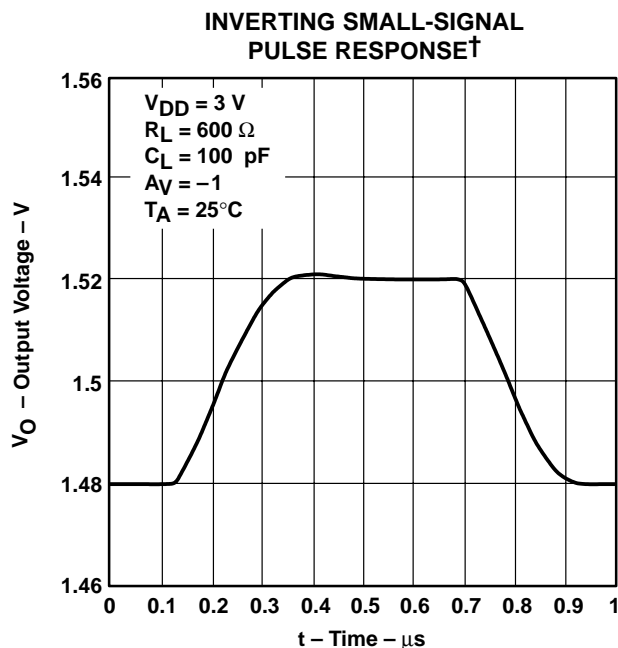
**VOLTAGE-FOLLOWER LARGE-SIGNAL PULSE RESPONSE†**



**Figure 38**

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

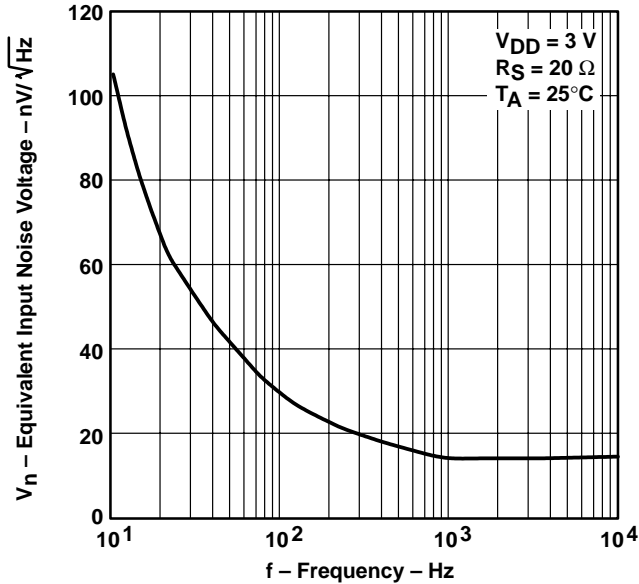
**TYPICAL CHARACTERISTICS**



† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

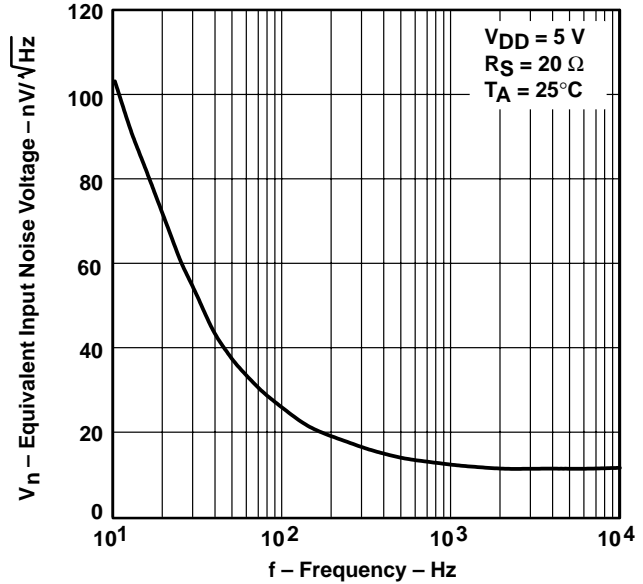
**TYPICAL CHARACTERISTICS**

**EQUIVALENT INPUT NOISE VOLTAGE†  
 VS  
 FREQUENCY**



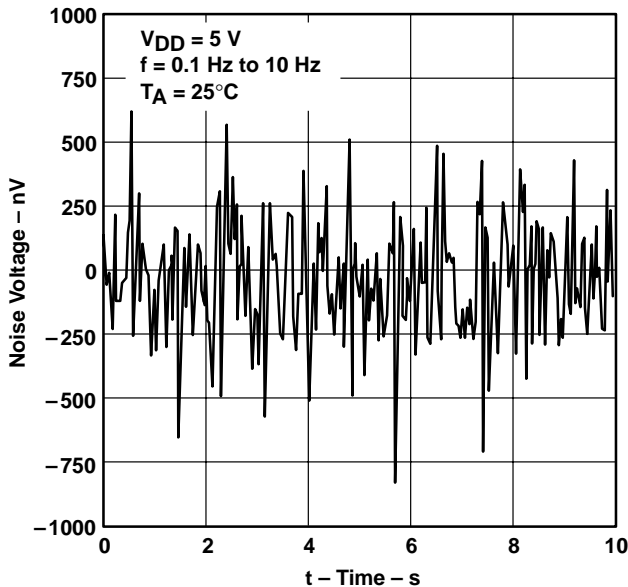
**Figure 43**

**EQUIVALENT INPUT NOISE VOLTAGE†  
 VS  
 FREQUENCY**



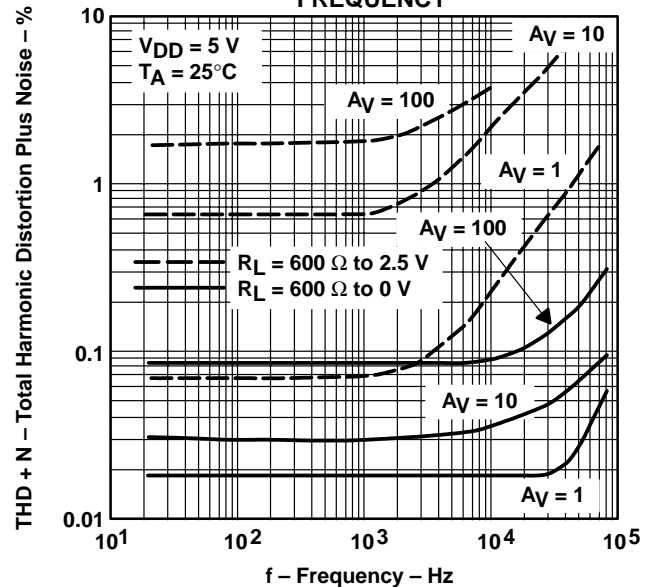
**Figure 44**

**INPUT NOISE VOLTAGE OVER  
 A 10-SECOND PERIOD†**



**Figure 45**

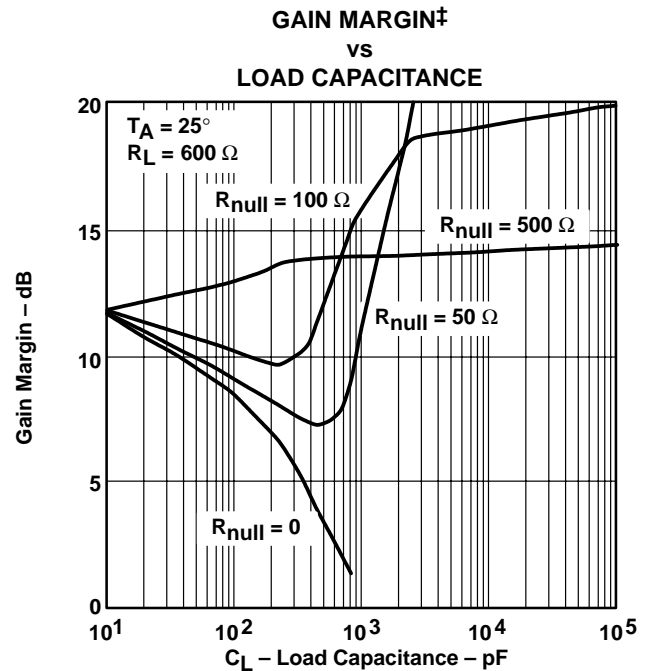
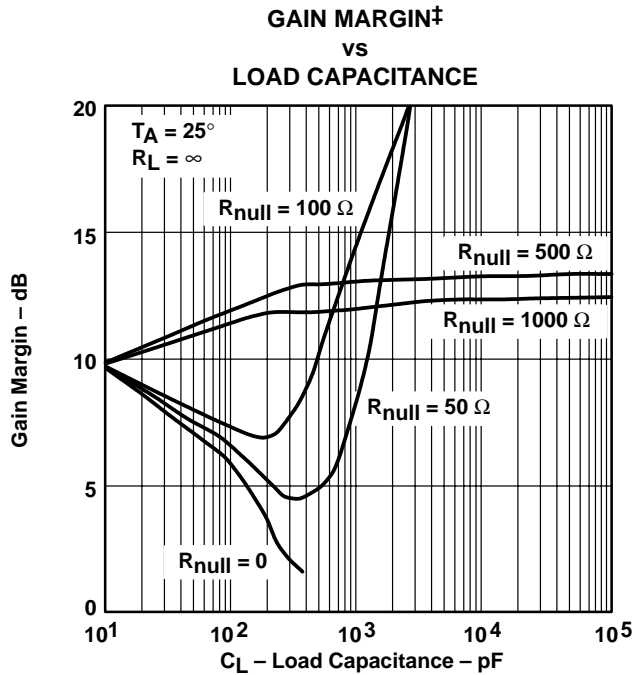
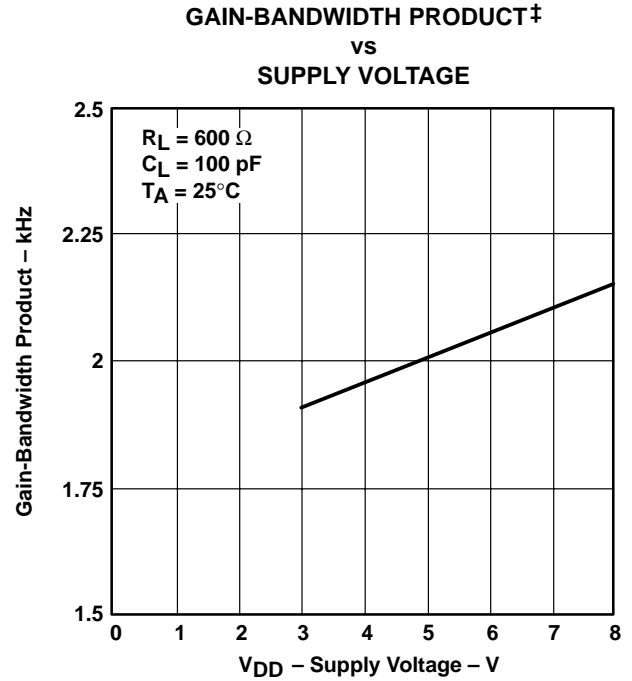
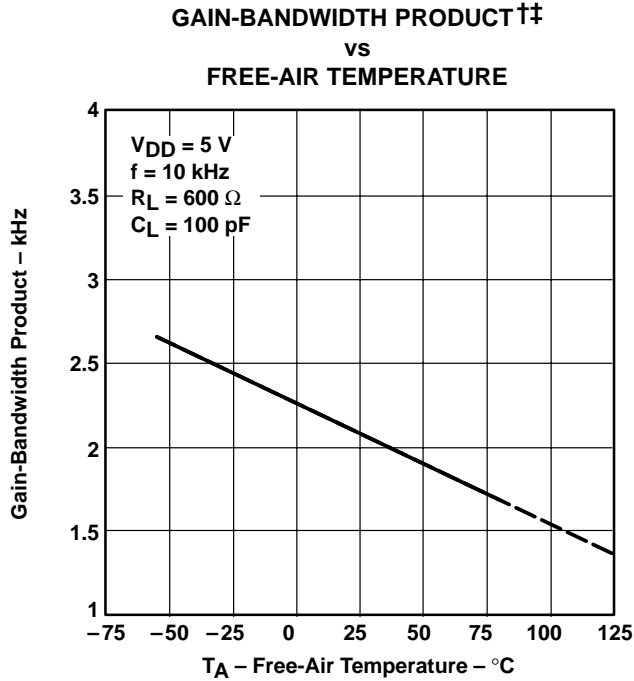
**TOTAL HARMONIC DISTORTION PLUS NOISE†  
 VS  
 FREQUENCY**



**Figure 46**

† For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

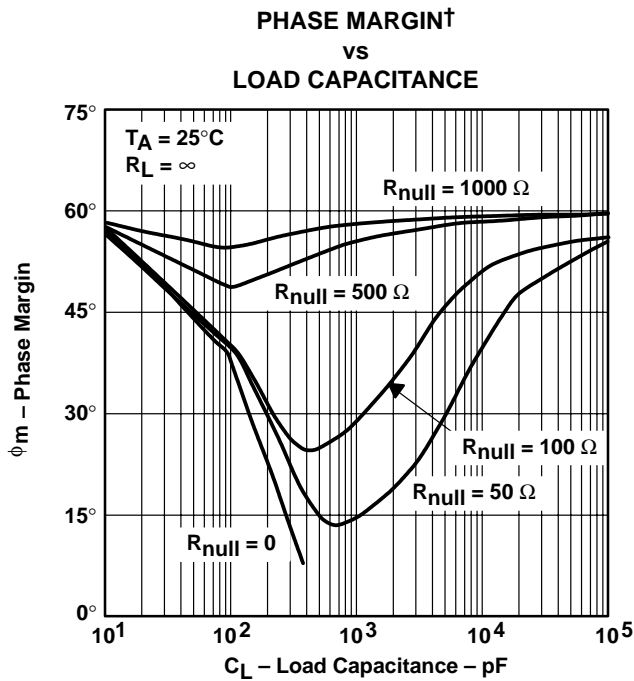
**TYPICAL CHARACTERISTICS**



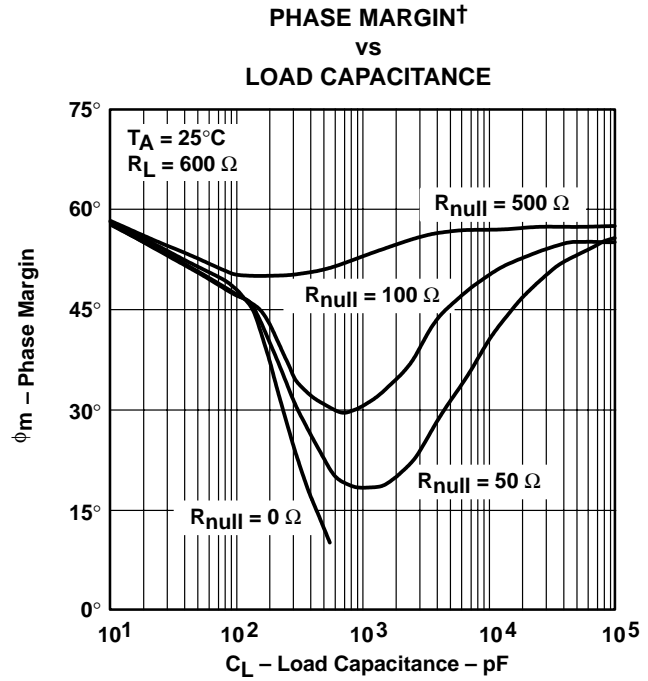
† Data at high and low temperatures are applicable only within the rated operating free-air temperature ranges of the various devices.

‡ For all curves where  $V_{DD} = 5\text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3\text{ V}$ , all loads are referenced to 1.5 V.

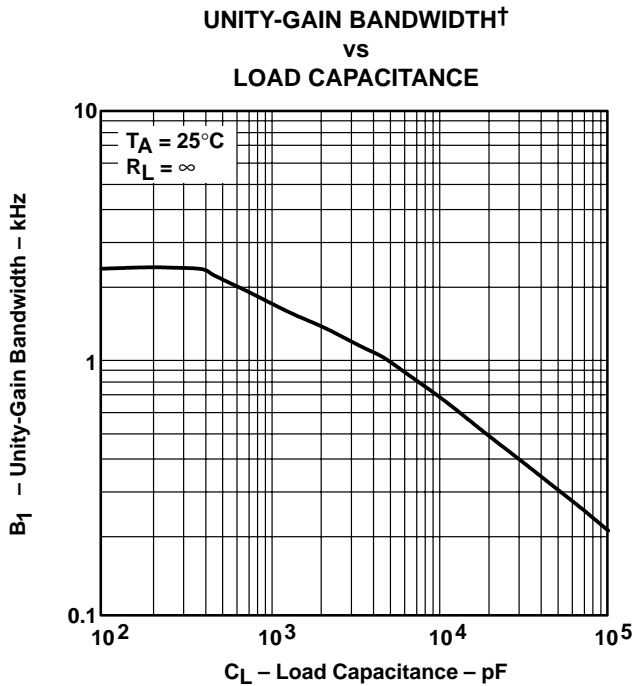
**TYPICAL CHARACTERISTICS**



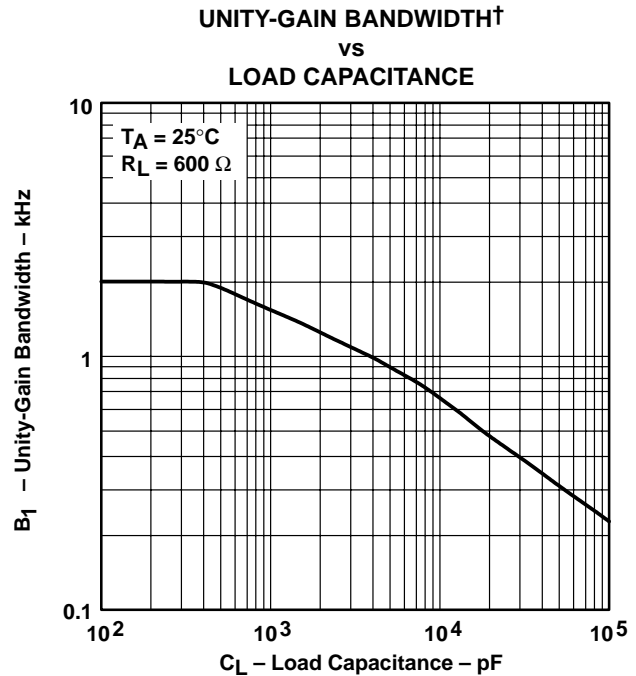
**Figure 51**



**Figure 52**



**Figure 53**



**Figure 54**

† For all curves where  $V_{DD} = 5 \text{ V}$ , all loads are referenced to 2.5 V. For all curves where  $V_{DD} = 3 \text{ V}$ , all loads are referenced to 1.5 V.



## APPLICATION INFORMATION

### driving large capacitive loads

The TLV2731 is designed to drive larger capacitive loads than most CMOS operational amplifiers. Figure 49 through Figure 54 illustrate its ability to drive loads greater than 100 pF while maintaining good gain and phase margins ( $R_{null} = 0$ ).

A small series resistor ( $R_{null}$ ) at the output of the device (see Figure 55) improves the gain and phase margins when driving large capacitive loads. Figure 49 through Figure 52 show the effects of adding series resistances of 50  $\Omega$ , 100  $\Omega$ , 500  $\Omega$ , and 1000  $\Omega$ . The addition of this series resistor has two effects: the first effect is that it adds a zero to the transfer function and the second effect is that it reduces the frequency of the pole associated with the output load in the transfer function.

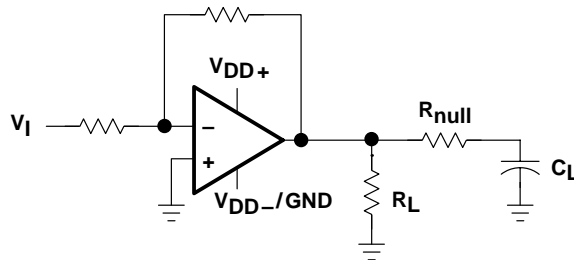
The zero introduced to the transfer function is equal to the series resistance times the load capacitance. To calculate the approximate improvement in phase margin, equation 1 can be used.

$$\Delta\phi_{m1} = \tan^{-1} \left( 2 \times \pi \times \text{UGBW} \times R_{null} \times C_L \right) \quad (1)$$

Where :

- $\Delta\phi_{m1}$  = Improvement in phase margin
- UGBW = Unity-gain bandwidth frequency
- $R_{null}$  = Output series resistance
- $C_L$  = Load capacitance

The unity-gain bandwidth (UGBW) frequency decreases as the capacitive load increases (see Figure 53 and Figure 54). To use equation 1, UGBW must be approximated from Figure 53 and Figure 54.



**Figure 55. Series-Resistance Circuit**

# TLV2731, TLV2731Y

## Advanced LinCMOS™ RAIL-TO-RAIL

### LOW-POWER SINGLE OPERATIONAL AMPLIFIERS

SLOS198A – AUGUST 1997 – REVISED MARCH 2001

#### APPLICATION INFORMATION

##### macromodel information

Macromodel information provided was derived using Microsim *Parts*™, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 6) and subcircuit in Figure 56 are generated using the TLV2731 typical electrical and operating characteristics at  $T_A = 25^\circ\text{C}$ . Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 6: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers," *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

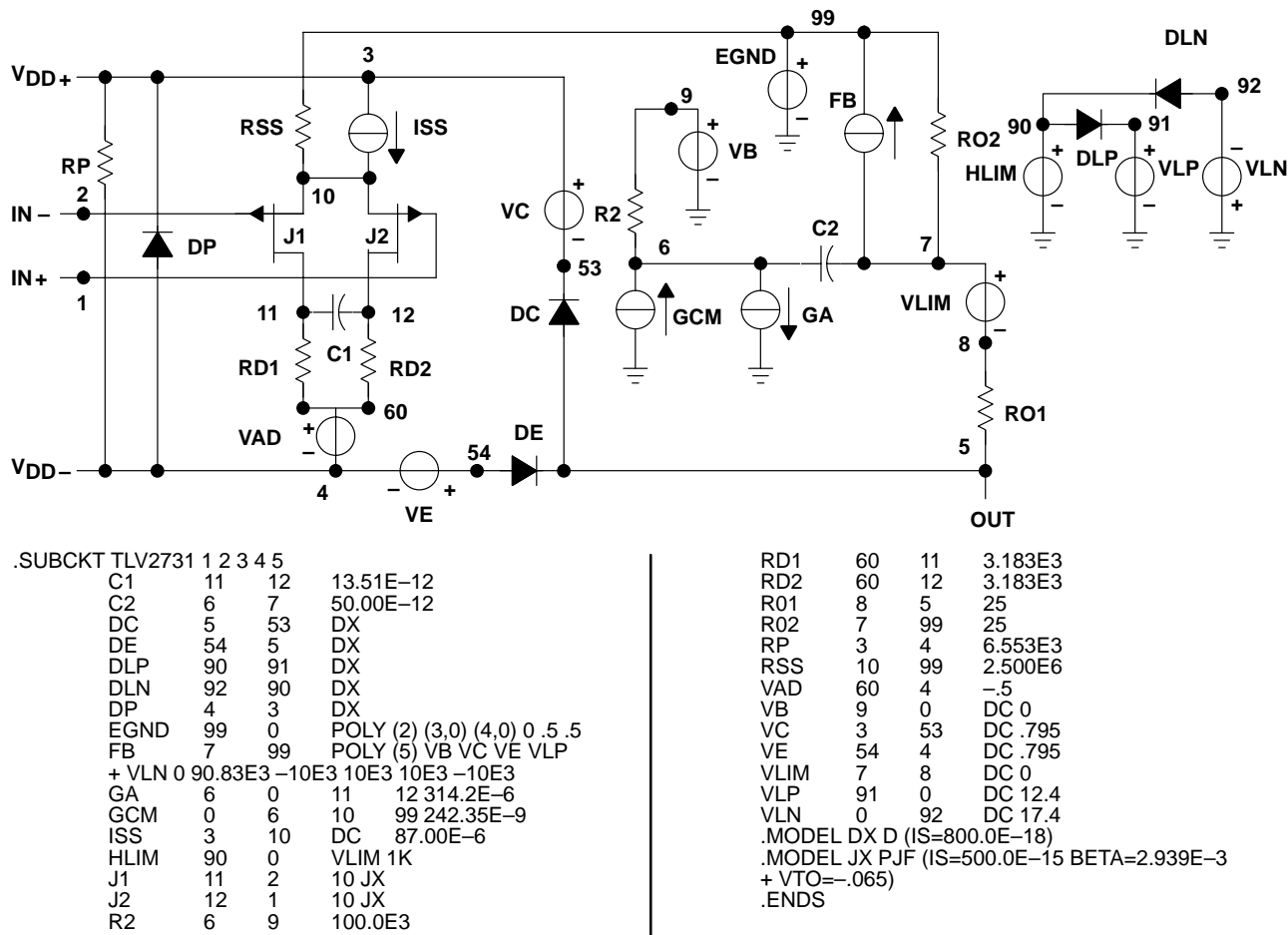


Figure 56. Boyle Macromodel and Subcircuit

*PSpice* and *Parts* are trademark of MicroSim Corporation.

Macromodels, simulation models, or other models provided by TI, directly or indirectly, are not warranted by TI as fully representing all of the specification and operating characteristics of the semiconductor product to which the model relates.

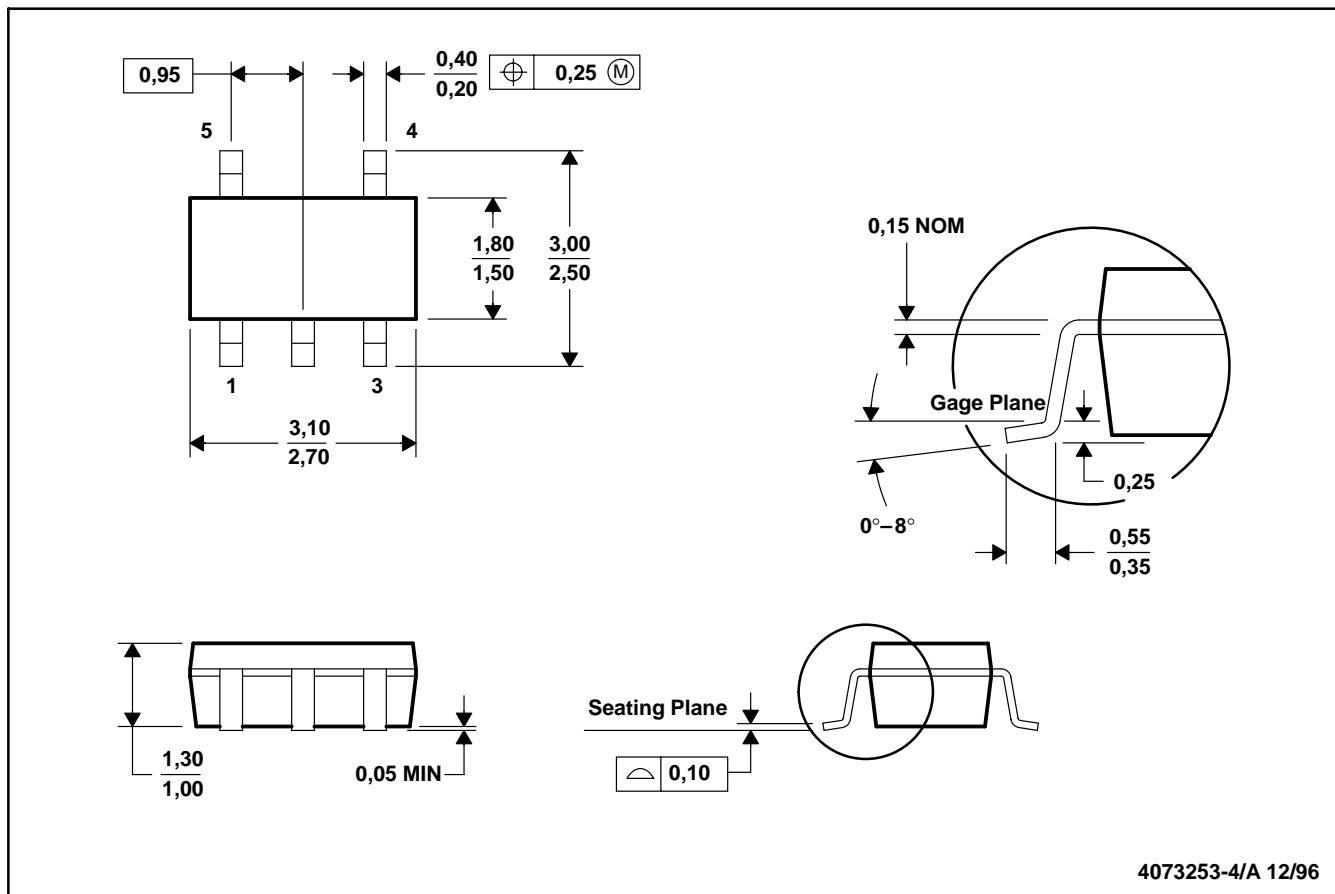


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**MECHANICAL INFORMATION**

**DBV (R-PDSO-G5)**

**PLASTIC SMALL-OUTLINE PACKAGE**



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions include mold flash or protrusion.

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
TLV2731CDBV	OBSOLETE	SOT-23	DBV	5		TBD	Call TI	Call TI
TLV2731CDBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2731CDBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2731CDBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2731CDBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2731IDBVR	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2731IDBVRG4	ACTIVE	SOT-23	DBV	5	3000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2731IDBVT	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
TLV2731IDBVTG4	ACTIVE	SOT-23	DBV	5	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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**TAPE AND REEL INFORMATION**



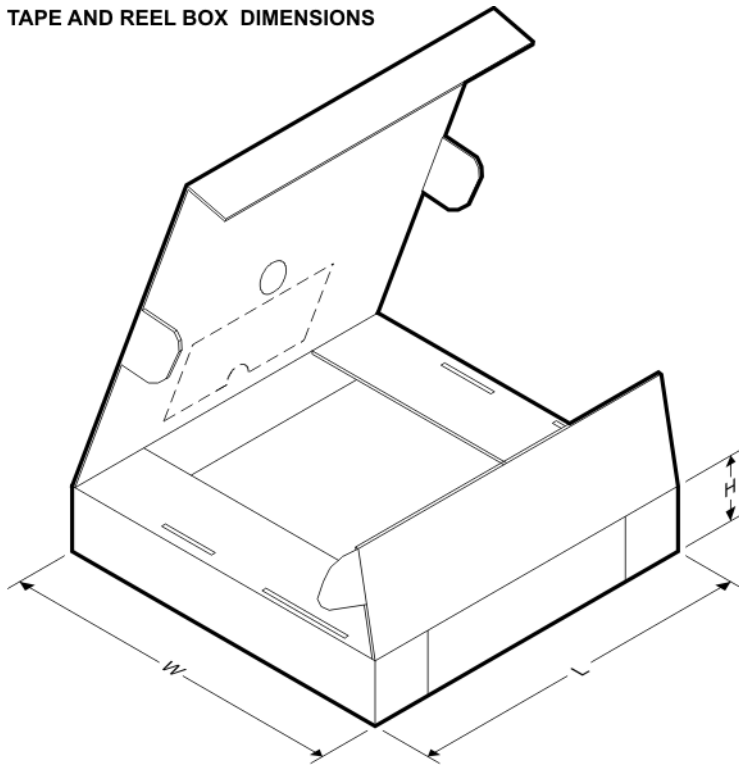
**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TLV2731CDBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TLV2731CDBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TLV2731IDBVR	SOT-23	DBV	5	3000	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3
TLV2731IDBVT	SOT-23	DBV	5	250	180.0	9.0	3.15	3.2	1.4	4.0	8.0	Q3

**TAPE AND REEL BOX DIMENSIONS**



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TLV2731CDBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TLV2731CDBVT	SOT-23	DBV	5	250	182.0	182.0	20.0
TLV2731IDBVR	SOT-23	DBV	5	3000	182.0	182.0	20.0
TLV2731IDBVT	SOT-23	DBV	5	250	182.0	182.0	20.0

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